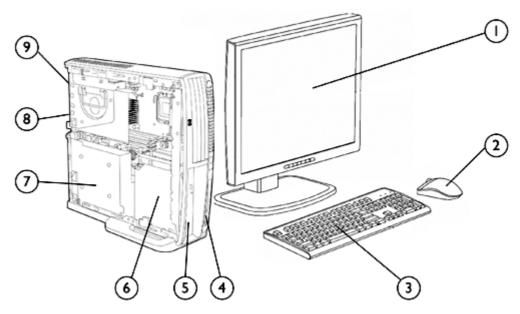
Overview

HP recommends Windows Vista® Business

Ultra-slim Desktop



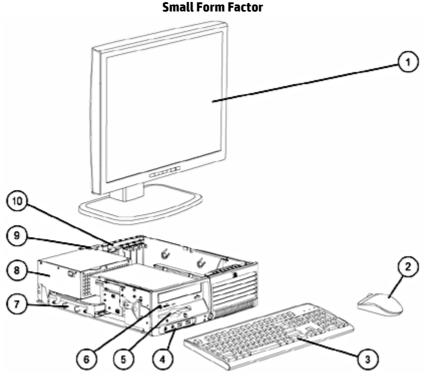
- 1. Monitor (sold separately)
- 2. 2-Button Scroll Mouse (PS/2) or Optical Scroll Mouse (PS/2 or USB)
- HP Standard Keyboard (PS/2 or USB) or HP USB Smartcard Keyboard
- 4. Front I/O: (2) USB 2.0, headphone and microphone
- 5. (1) Slimline Drive Bay

- 6. (1) 3.5" internal bay
- 7. 200-watt Active Power Factor Correction (PFC) power supply
- 8. (1) full-height PCI slot (requires optional PCI riser), (1) low profile PCI Express x16 slot (requires optional PCIe x16 riser)*
- 9. Rear I/O: (6) USB 2.0, (1) optional serial port (available via adapter), (1) optional parallel port (available via adapter), (1) optional DVI graphics port (available via DVI ADD2 adapter), (2) PS/2, (1) RJ-45, (1) VGA, audio in/out



^{*} Only one optional PCI riser card (the PCI riser or the PCI Express x16 riser) or one PCI Serial and parallel I/O adapter is allowed.

Overview



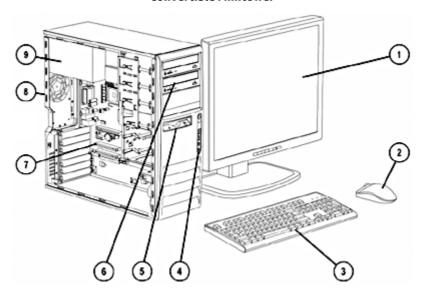
- 1. Monitor (sold separately)
- 2. 2-Button Scroll Mouse (PS/2) or Optical Scroll Mouse (PS/2 or USB)
- 3. HP Standard Keyboard (PS/2 or USB) or HP USB Smartcard Keyboard
- 4. Front I/O: (2) USB 2.0, headphone and microphone
- 5. (1) 3.5" external bay for optional HP 16-in-1 Media Card Reader, diskette drive, or other 3.5" device
- 6. (1) 5.25" external bay for optional optical drive, or other 5.25" 10. (2) low profile PCI slots, (1) low profile PCI Express x1 slot, (1) device (bay tilts up for device removal and insertion)

- 7. (1) 3.5" internal bay
- 8. 240-watt or 240-watt high efficiency 80 PLUS® Active Power Factor Correction (PFC) power supply
- 9. Rear I/O: (6) USB 2.0, (1) standard serial port, (1) optional serial port, (1) parallel port, (2) PS/2, (1) RJ-45, (1) VGA, (1) optional DVI graphics port (available via DVI ADD2 adapter), audio in/out
- low profile PCI Express x16 slot; (2) full-height PCI slots optional (require PCI riser card)*

^{*} With riser card option, PCI Express x1 and x16 slots are inaccessible.

Overview

Convertible Minitower



- 1. Monitor (sold separately)
- 2-Button Scroll Mouse (PS/2) or Optical Scroll Mouse (PS/2 or USB)
- 3. HP Standard Keyboard (PS/2 or USB) or HP USB Smartcard Keyboard
- 4. Front I/O: (2) USB 2.0, headphone and microphone
- 5. (1) 3.5" external bay for optional HP 16-in-1 Media Card Reader, diskette drive, or other 3.5" device
- 6. (3) 5.25" external bays and (2) 3.5" internal bays

- 7. (2) full-height PCI slots, (1) full-height PCI Express x1 slot,
 (1) full-height PCI Express x16 slot, (2) additional full-height
 PCI slots optional
- 8. Rear I/O: 6 USB 2.0, 1 standard serial port, 1 optional serial port, 1 parallel port, 2 PS/2, 1 RJ-45, 1 VGA, audio in/out, mic in
- 9. 365-watt or 365-watt high efficiency 80 PLUS Active Power Factor Correction (PFC) power supply



Overview

At A Glance

- Designed for long-term, networked deployment within medium and large organizations in commercial business, finance and public sector industries
- Created using industry leading Design for Environment standards. Upgradeable, recyclable and energy efficient.
- Long purchase lifecycles and image stability for demanding enterprise environments
- Support for new Intel technologies introduced in 2006: Intel® Q965 Express chipset, Intel Core™ 2 Duo Processors, and Intel Graphics Media Accelerator 3000 integrated graphics
- Select models with new Intel vPro technology support the latest in manageability and security technology
- Value-added software on select models
 - HP Total Care Advisor
 - O HP ProtectTools Security Software Suite, including embedded security, preinstalled standard
 - O HP Backup and Recovery Manager
 - O HP Software Agent
 - O Altiris Deployment Solution Agent
 - O Symantec AntiVirus 10.0 with 60 day Live Update Subscription
 - O HP Insight Diagnostics software
 - O Microsoft Office 2007
 - PDF Complete
 - Computrace for Desktops
- Value-added software available for free download from the Web (http://www.hp.com/go/easydeploy)
 - O HP Client Configuration Manager, Basic Edition
 - HP Out-of-Band Management Console (for Intel AMT enabled models)
 - O HP Client Manager for Altiris
 - O Altiris Out-of-Band Management Solution (for Intel AMT enabled models)
 - O HP SoftPaq Download Manager
 - O HP System Software Manager
 - O HP Client Catalog for Microsoft SMS
 - O Verdiem Surveyor remote power management agent
- Fully compatible software OS image across all three models (Ultra-slim Desktop, Small Form Factor, and Convertible Minitower)
- HP BIOS for better security, manageability and software image stability
- Selected configurations with global availability easily set up and ordered through HP.com Business to Business portals (http://h10019.www1.hp.com/business-site/index.html)
- Tailored HP Factory Express deployment and lifecycle services available (http://h71028.www7.hp.com/enterprise/cache/97688-0-0-225-121.aspx)
- Protected by HP Services, including standard warranties up to 5-5-5 (terms and conditions vary by country; certain restrictions and exclusions apply)
- Security
 - Embedded TPM1.2 compliant security module* (requires HP ProtectTools Embedded Security software), providing compatibility with future security features expected in Microsoft Vista
 - O Redundant Array of Independent Disks (RAID) 1 configurations to protect data against hardware failures
 - HP Backup and Recovery Manager to protect data against software corruption or incompatibilities due to patching or upgrades
- Tool-less serviceability features for easier upgrades and repairs
- Choice of professional chassis form factors to accommodate the desired mix between expandability and size

NOTE: All models and features may not be available in all countries.

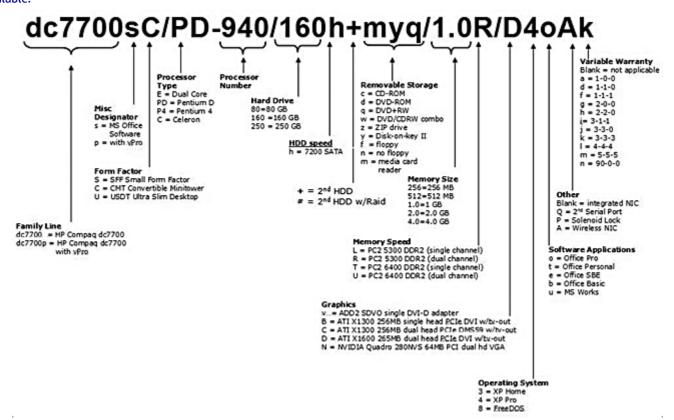


^{*} TPM module disabled where use is restricted by law; for example, Russia.

Configurable Components - Select Models (localized by Regions)

Model Key and Example

NOTE: This diagram is an example that illustrates how to read the model number. It is not intended to give every available configuration choice specified in the body of this document and may include references to modules that are out of date and no longer available.



Standard Features and Configurable Components

Operating System – One of the following **Preinstalled** Genuine Windows Vista Business 32*

Genuine Windows Vista Home Basic 32* Genuine Windows XP Professional SP2 Genuine Windows XP Home SP2

FreeDOS[†]

Supported Genuine Windows 2000

* Certain Windows Vista product features require advanced or additional hardware. See http://www.microsoft.com/windowsvista/getready/hardwarereqs.mspx and http://www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit http://www.windowsvista.com/upgradeadvisor.

[†] The following features are not supported by Linux:

- HP 16-in-1 Media Card Reader
- Intel PRO/1000 PT PCIe Gigabit NIC)
- Broadcom NetXtreme Gigabit PCIe NIC
- Wireless A+G PCI Card (full height and low profile)
- HP BT450 USB Bluetooth Wireless Printer and PC Adapter
- Agere 2006 PCI 56K International SoftModem
- DVI-D ADD2 SDVO single head Graphics Adapter (PCIe x16)
- ATI Radeon X1300 (256MB SH) PCIe Card, DVI w/TV
- ATI Radeon X1300 Pro (256MB DH) PCIe Graphics Card
- ATI Radeon X1600XT (256MB DH) full-height PCIe Card, DVI w/TV-out
- NVIDIA Quadro NVS 280 (64MB DH) PCI VGA Card
- NVIDIA Quadro NVS 285 (128MB DH) PCIe x16 VGA Card
- NVIDIA Quadro NVS 290 (256MB DH) PCIe x16 Graphics Card
- HP USB Smartcard Keyboard
- HP FireWire / IEEE 1394 PCI Card
- HP Serial & Parallel IO Adapter
- HP 2nd Serial Port
- Belkin USB to Serial Adapter

NOTE: Drivers for Windows Vista are continually being made available for download from http://www.hp.com.



Standard Features and Configurable Components

Value-added Software (on HP ProtectTools Security Solutions select models; not included Altiris Deployment Solution Agent

with FreeDOS)

HP Software Agent

HP Insight Diagnostics

(available via HP Backup and Recovery Manager)

Computer Setup Utility

HP Backup and Recovery Manager

Symantec AntiVirus 10.0 with 60 day Live Update

Subscription

Sonic/Roxio DigitalMedia Plus 7.2

(select models)

Easy Media Creator 9 (select models)

HP Total Care Advisor

Microsoft Office 2007 Basic

Microsoft Office 2007 Personal

Microsoft Office 2007 Professional

Microsoft Office 2007 Small Business

Microsoft Works 8.5

Microsoft Internet Explorer with Google Toolbar

PDF Complete

Computrace for Desktops Verdiem Surveyor agent

InterVideo WinDVD 5.0 (select models)

Value-added Software

(available for free download from the Web http://www.hp.com/go/ easydeploy)

HP Client Configuration Manager, Basic Edition

HP Client Manager for Altiris

HP SoftPaq Download Manager **HP Client Catalog for Microsoft SMS** HP Out-of-Band Management Console (for Intel AMT

enabled models)

Altiris Out-of_Band Management Solution (for Intel

AMT enabled models)

HP Systems Software Manager

Verdiem Surveyor agent

Value-added Services and HP Stable Platform Program **Features**

Business-to-Business Portals HP Global Series Services

Factory Express Deployment and Lifecycle Services

TPM 1.2 Security* Intel vPro technology

* TPM module disabled where use is restricted by law; for example, Russia.

Service and Support

On-site Warranty and Service 1: This three-year (3-3-3), limited warranty and service offering delivers three years of parts, labor and on-site repair. Response time is next business-day² and includes free telephone support³ 24 x 7. Global coverage² ensures that any product purchased in one country and transferred to another non-restricted country will remain fully covered under the original warranty and service offering. Some countries/regions do not offer one year onsite and labor.

¹ Terms and conditions may vary by country. Certain restrictions and exclusions apply.

² On-site service may be provided pursuant to a service contract between HP and an authorized HP thirdparty provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

³ Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.

Standard Features and Configurable Components

Dimensions				
Chassis Dimensions	2.95 x 12.4 x 13.18 in	3.95 x 13.3 x 14.9 in	17.65 x 6.6 x 17.8 in	
(H x W x D)	(7.49 x 31.50 x 33.48 cm)	(10.03 x 33.78 x 37.85 cm)	(44.83 x 16.76 x 45.21 cm)	
System weight*	12.08 lb (5.48 kg)	17.18 lb (7.79 kg)	31.18 lb (14.14 kg)	
System volume	7.9 liters	12.8 liters	33.8 liters	
Shipping weight*	19.20 lb (8.71 kg)	25.10 lb (11.39 kg)	39.5 lb (17.92 kg)	
Maximum supported weight (desktop orientation)	77.1 lb (35 kg)	77.1 lb (35 kg)	77.1 lb (35 kg)	
Shipping box dimensions	12.63 x 18.75 x 20 in	12.63 x 18.75 x 20 in	23.38 x 13.06 x 22.88 in	
(H x W x D)	(32.08 x 47.63 x 50.8 cm)	(32.08 x 47.63 x 50.8 cm)	(59.39 x 33.17 x 58.12 cm)	
* Configured with 1 hard driv	e, 1 optical drive, no diskette drive,	and no PCI card.		
Power Supply	200W power supply – Active PFC	240W power supply – Active PFC	365W power supply – Active PFC	
80 PLUS® Power Supply		240W 80 PLUS* power supply – Active PFC	365W 80 PLUS* power supply – Active PFC	
* This alternate 80% efficien processors and modules.	t power supply is a requirement for	ENERGY STAR® compliance in conju	nction with a select range of	
Ports				
USB 2.0	8 (2 front, 6 rear)	8 (2 front, 6 rear)	8 (2 front, 6 rear)	
Serial	1 optional via Serial & parallel I/O adapter	1 standard with 2nd optional	1 standard with 2nd optional	
Parallel	1 optional via Serial & parallel I/O adapter	1	1	
PS/2		1 keyboard, 1 mouse		
Video		analog for integrated graphics		
DVI output	availab	le via ADD2 card, PCI-E x16 card, or I	PCI card	
Support for Multi-Monitor	availab	le via ADD2 card, PCI-E x16 card, or I	PCI card	
Audio	Front – mic ar	nd headphone	Front – mic and headphone	
	Rear – line in, line out Rear – line in, line out, mic ir			
NIC (RJ-45)	Integrated Int	el 82566DM Gigabit Network Conne	ction Ethernet	

		USDT	SFF	CMT
Chipset	Intel Q965 Express chipset	Χ	Χ	Χ



USDT

Х

Χ

Χ

Χ

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Χ

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SFF

CMT

QuickSpecs

Processor and Speed*

Standard Features and Configurable Components

Intel Celeron D Processors:

•				
One of the following	Intel Celeron D 331 Processor (2.66-GHz, 256K L2 cache, 533-MHz FSB)	X	Χ	Χ
	Intel Celeron D 347 Processor (3.06-GHz, 512K L2 cache, 533-MHz FSB)	Χ	Χ	Χ
	Intel Celeron D 352 Processor (3.20-GHz, 512K L2 cache, 533-MHz FSB)	Χ	Χ	Χ
	Intel Celeron D 360 Processor (3.46-GHz, 512K L2 cache, 533-MHz FSB)	Χ	Χ	Χ
	Intel Celeron Processors:			
	Intel Celeron 420 Processor (1.6-GHz, 512K L2 cache, 800-MHz FSB)	Х	Χ	Χ
	Intel Celeron 430 Processor (1.8-GHz, 512K L2 cache, 800-MHz FSB)	Χ	Χ	Χ
	Intel Celeron 440 Processor (2.0-GHz, 512K L2 cache, 800-MHz FSB)	Χ	Χ	Χ
	Intel Pentium 4 Processors with Hyper Threading Technology:			
	Intel Pentium 4 531 Processor (3.0-GHz, 1-MB L2 cache, 800-MHz FSB)	Χ	Χ	Χ
	Intel Pentium 4 541 Processor (3.2-GHz, 1-MB L2 cache, 800-MHz FSB)	Χ	Χ	Χ
	Intel Pentium 4 631 Processor (3.0-GHz, 2-MB L2 cache, 800-MHz FSB)	Χ	Χ	Χ
	Intel Pentium 4 641 Processor (3.2-GHz, 2-MB L2 cache, 800-MHz FSB)	Χ	Χ	Χ
	Intel Pentium 4 651 Processor (3.4-GHz, 2-MB L2 cache, 800-MHz FSB)	Х	Χ	Χ

Intel Pentium 4 661 Processor (3.6-GHz, 2-MB L2 cache, 800-MHz FSB)

Intel Pentium D 915 Processor (2.8-GHz, 2x2MB L2 cache, 800-MHz FSB

Intel Pentium D 925 Processor (3.0-GHz, 2x2MB L2 cache, 800-MHz FSB)

Intel Pentium D 935 Processor (3.2-GHz, 2x2MB L2 cache, 800-MHz FSB)

Intel Pentium D 945 Processor (3.4-GHz, 2x2MB L2 cache, 800-MHz FSB)

Intel Pentium dual-core Processors:

Intel Pentium E2140 Processor (1.6-GHz, 1-MB L2 cache, 800-MHz FSB) X
Intel Pentium E2160 Processor (1.8-GHz, 1-MB L2 cache, 800-MHz FSB) X

Intel Core 2 Duo Processors:

Intel Pentium D Processors:

Intel Core 2 Duo E4300 Processor (1.80-GHz, 2 MB L2 cache, 800-MHz FSB) Χ Χ Χ Intel Core 2 Duo E4400 Processor (2.00-GHz, 2 MB L2 cache, 800-MHz FSB) Χ Χ Χ Intel Core 2 Duo E6300 Processor (1.86-GHz, 2 MB L2 cache, 1066-MHz FSB) Χ Χ Χ Intel Core 2 Duo E6320 Processor (1.86-GHz, 4 MB L2 cache, 1066-MHz FSB) Χ Χ Χ Intel Core 2 Duo E6400 Processor (2.13-GHz, 2 MB L2 cache, 1066-MHz FSB) Х Х Χ Intel Core 2 Duo E6420 Processor (2.13-GHz, 4 MB L2 cache, 1066-MHz FSB) Χ Х Χ Intel Core 2 Duo E6600 Processor (2.40-GHz, 4 MB L2 cache, 1066-MHz FSB) Χ Χ Χ Χ Χ Intel Core 2 Duo E6700 Processor (2.66-GHz, 4 MB L2 cache, 1066-MHz FSB) Χ



^{*} Intel processor numbers are not a measure of performance. Processor numbers differentiate features within each processor family, not across different processor families.

Х

QuickSpecs

Standard Features and Configurable Components

USDT SFF **CMT** Χ

Χ

Intel vPro Technology*

Uses AMT 2.0 (Active Management Technology) for network alerting and management of systems regardless of power state, as well as operating system-

absent environments

Memory

DDR2 SYNCH DRAM NON-ECC MEMORY

Memory upgrades are accomplished by adding single or multiple DIMMs of the same or varied sizes. This chart does not represent all possible memory configurations. The Intel Q965 Express chipsets support non-ECC DDR2 PC2-5300 (667-MHz) and PC2-6400 (800-MHz) memory.

CAUTION: You must shut down the computer and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

HP recommends dual-channel symmetric configurations for maximum performance.

For best performance, add the same amount of total memory to each channel and do not mix speeds. For dual-channel symmetric performance, the total amount of memory in each channel must be equal. If speeds are mixed, speed will default to the slowest DIMM.

Ultra-slim Desktop

Maximum Memory*

Supports up to 3 GB of DDR2 SYNCH DRAM. Slot 1 is black and must always be populated. Not all memory configurations possible are represented below.

DIMM Size	Slot				
	Char	Channel B			
	1 (black)	2 (white)	3 (white)		
512-MB	512-MB				
512-MB (dual-channel symmetric)	256-MB		256-MB		
1-GB	1-GB				
1-GB (dual channel symmetric)	512-MB		512-MB		
3-GB maximum	1-GB	1-GB	1-GB		

^{*} The Intel Q965 Express chipset includes a built-in Management Engine (ME), which allocates memory for manageability functions. Management Engine memory is shared with system memory. If the PC contains a single DIMM, 8 MB of memory is pre-allocated for it at system startup. If the PC contains two DIMMs, 16 MB of memory is pre-allocated. This memory is not made available to the operating system, just as pre-allocated video memory is not available.



^{*} Units configured with this feature are referred to as HP Compaq dc7700p Business PCs.

Standard Features and Configurable Components

Small Form Factor and Convertible Minitower

Maximum Memory*

Supports up to 8 GB of DDR2 SYNCH DRAM. Slot 1 is black and must always be populated. Not all

memory configurations possible are represented below.

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.

DIMM Size		Slot			
	Cha	annel A	Channel B		
	1 (black)	2 (white)	3 (white)	4 (white)	
512-MB	512-MB				
512-MB (dual-channel symmetric)	256-MB		256-MB		
1-GB	1-GB				
1-GB (dual-channel symmetric)	512-MB		512-MB		
1-GB (dual-channel symmetric)	256-MB	256-MB	512-MB		
2-GB (dual-channel symmetric)	1-GB		512-MB	512-MB	
2-GB (dual-channel symmetric)	512-MB	512-MB	512-MB	512-MB	
3-GB (dual-channel symmetric)	1-GB	512-MB	1-GB	512-MB	
4-GB (dual-channel symmetric)	1-GB	1-GB	1-GB	1-GB	
8-GB maximum (dual-channel symmetric)	2-GB	2-GB	2-GB	2-GB	

^{*} The Intel Q965 Express chipset includes a built-in Management Engine (ME), which allocates memory for manageability functions. Management Engine memory is shared with system memory. If the PC contains a single DIMM, 8 MB of memory is pre-allocated for it at system startup. If the PC contains two DIMMs, 16 MB of memory is pre-allocated. This memory is not made available to the operating system, just as pre-allocated video memory is not available.



Standard Features and Configurable Components

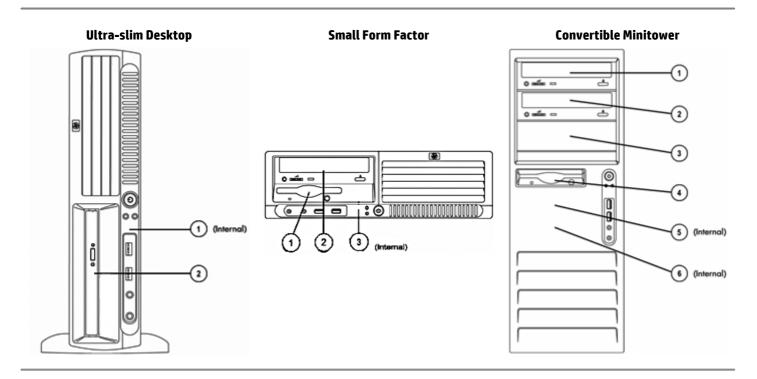
Memory Configurations –
One of the following

-	USDT	SFF	CMT
512-MB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (1 x 512)	Χ	Χ	Χ
512-MB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (2 x 256)	Χ	Χ	Χ
1-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (1 x 1GB)	Χ	Χ	Χ
1-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (2 x 512)	Χ	Χ	Χ
2-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (2 x 1GB)	Χ	Χ	Χ
2-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (4 x 512)		Χ	Χ
3-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (3 x 1GB)	Χ	Χ	Χ
4-GB DDR2 Synch Dram PC2-6400 (800-MHz) Non ECC (4 x 1GB)		Χ	Χ
512-MB DDR2 Synch Dram PC2-5300 (667-MHz) Non ECC (1 x 512)	Χ	Χ	Χ
512-MB DDR2 Synch Dram PC2-5300 (667-MHz) Non ECC (2 x 256)	Χ	Χ	Χ
1-GB DDR2 Synch Dram PC2-5300 (667-MHz) Non ECC (1 x 1GB)	Χ	Χ	Χ
1-GB DDR2 Synch Dram PC2-5300 (667-MHz) Non ECC (2 x 512)	Χ	Χ	Χ
2-GB DDR2 Synch Dram PC2-5300 (667-MHz) Non ECC (2 x 1GB)	Χ	Χ	Χ
2-GB DDR2 Synch Dram PC2-5300 (667-MHz) Non ECC (4 x 512)		Χ	Χ
3-GB DDR2 Synch Dram PC2-5300 (667-MHz) Non ECC (3 x 1GB)	Χ	Χ	Χ
3-GB DDR2 Synch Dram PC2-5300 (667-MHz) Non ECC (2 x 1GB, 2 x 512)		Χ	Χ
4-GB DDR2 Synch Dram PC2-5300 (667-MHz) Non ECC (4 x 1GB)		Χ	Χ

Expandability	USDT	SFF	CMT	
PCI slots	Optional, requires PCI riser: 1 full-height (4.2"), length (6.6")	2 low-profile (2.5"), length (6.6") standard;	2 full-height (4.2"), length (13.4") standard;	
	-	2 full-height (4.2"), length (6.875")	(2 additional full-height slots	
		via optional riser card.	available via optional PCI extender	
		NOTE: With riser card option, PCIe	card)	
		x1 and PCIe x16 slots are not		
		accessible.		
Max power per slot	25W	25W	25W	
PCI Express x16 slot	Optional, requires PCIe x16 riser: 1 low-profile (3.987"), length (6.60")	1 low-profile (2.5"), length (6.6")	1 full-height (4.2"), length (10.5")	
Max power per slot	25W	25W	75W	
PCI Express x1 slot	N/A	1 low profile (2.5"), length (6.6")	1 full-height (4.2"), length (13.4")	
Max power per slot	N/A	10W	10W	
External Bays	1 Slimline (WxDxH):	2	4	
	128 x 127 x 12.7 mm			
3.5"	N/A	1	1	
5.25"	N/A	1 (length 8.189")	3 (2 – length 8.189", 1 – length 5.71")	
Internal 3.5" HDD Bays	1	1	2	
Hard Drive Controller (PCI) Supported	Serial ATA (su	support for SATA 1.5-Gb/s and 3.0-Gb/s hard drives)		
Hard Drive and Optical SATA Interfaces Supported	1 Serial ATA interface	3 Serial ATA interfaces	4 Serial ATA interfaces	



Standard Features and Configurable Components



Storage – Drive Support

	US	DT		SFF			CN	1T	
	Slimline Drive Bay	3.5" Serial ATA Hard Drive	Diskette Drive or PCI Media Card Reader (optional)	Storage Drive Bay	3.5" Serial ATA Hard Drives	Diskette Drive	PCI Media Card Reader (optional)	Storage Drive Bays for multiple Optical Drives	3.5" Serial ATA Hard Drives
Quantity Supported	1	1	1	1	2	1	1	3	3
Position Supported	2	1	1	2	1,3	4	(1) (2) (3)	①,②, ③	(4,(5), (6)
Controller	SATA to IDE Bridge	SATA	Diskette Controller or USB header on PCI card	SATA	SATA	Diskette Controller	USB header on PCI card	SATA	SATA

Standard Features and Configurable Components

		USDT	SFF	CMT
Hard Drive –	80-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 rpm)	Χ	Χ	Χ
One or two of the following	160-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 rpm)	Χ	Χ	Χ
	250-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 rpm)	Χ	Χ	Χ
	or two of the following 160-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 rpm) 250-GB SATA 3.0-Gb/s Hard Drive (16MB Cache, 7200 rpm) 80-GB SATA 3.0-Gb/s Hard Drive (16MB Cache, 10,000 RPM, NCQ, Smart III) 160-GB SATA 3.0-Gb/s Hard Drive (16MB Cache, 10,000 RPM, NCQ, Smart III) Removable 3.5" 80-GB SATA 3.0 Gb/s (7200 rpm) Removable 3.5" 250-GB SATA 3.0 Gb/s (7200 rpm) Removable 3.5" 250-GB SATA 3.0 Gb/s (7200 rpm) RAID 80-GB SATA 3.0-Gb/s Hard Drive (7200 rpm) RAID 80-GB SATA 3.0-Gb/s Hard Drive (7200 rpm) RAID 250-GB SATA 3.0-Gb/s Hard Drive (7200 rpm) RAID 250-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 rpm) 2nd hard drive, 80-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 rpm) 2nd hard drive, 160-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 rpm) 2nd hard drive, 80-GB SATA 3.0-Gb/s Hard Drive (16MB Cache, 7200 rpm) 2nd hard drive, 80-GB SATA 3.0-Gb/s Hard Drive (16MB Cache, 10,000 RPM, NCQ, Smart III) 2nd hard drive, 80-GB SATA 3.0-Gb/s Hard Drive (16MB Cache, 10,000 RPM, NCQ, Smart III) 2nd hard drive, 160-GB SATA 3.0-Gb/s Hard Drive (16MB Cache, 10,000 RPM, NCQ, Smart III) 2nd hard drive, 160-GB SATA 3.0-Gb/s Hard Drive (16MB Cache, 10,000 RPM, NCQ, Smart III) 2nd hard drive, 160-GB SATA 3.0-Gb/s Hard Drive (16MB Cache, 10,000 RPM, NCQ, Smart III) 2nd hard Drives 5ATA DVD+/-RW (DL/DF) LightScribe Drive 5ATA DVD+/-RW (DL/DF) LightScribe Drive 5ATA DVD+/-RW (DL/DF) SuperMulti LightScribe Drive 5ATA DVD+/-RW (DL/DF) SuperMulti LightScribe Drive 5ATA DVD+/-RW Slim Drive PATA CD-RW/DVD-ROM Combo Slim Drive PATA DVD+/-RW Slim Drive PATA DVD-/-RW Slim Drive PATA DVD-ROM Slim Drive		Χ	Χ
	160-GB SATA 3.0-Gb/s Hard Drive (16MB Cache, 10,000 RPM, NCQ, Smart III)		Χ	Χ
	Removable 3.5" 80-GB SATA 3.0 Gb/s (7200 rpm)		Χ	Χ
	Removable 3.5" 160-GB SATA 3.0 Gb/s (7200 rpm)		Χ	Χ
	Removable 3.5" 250-GB SATA 3.0 Gb/s (7200 rpm)		Χ	Χ
	RAID 80-GB SATA 3.0-Gb/s Hard Drive (7200 rpm)		Χ	Χ
	RAID 160-GB SATA 3.0-Gb/s Hard Drive (7200 rpm)		Χ	Χ
	RAID 250-GB SATA 3.0-Gb/s Hard Drive (7200 rpm)		Χ	Χ
	2nd hard drive, 80-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 rpm)		Χ	Χ
	2nd hard drive, 160-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 rpm)		Χ	Χ
	2nd hard drive, 250-GB SATA 3.0-Gb/s Hard Drive (8MB Cache, 7200 rpm)		Χ	Χ
				X
	2nd hard drive, 160-GB SATA 3.0-Gb/s Hard Drive (16MB Cache, 10,000 RPM, NCQ, Smart III)			Х
Removable Storage –	Diskette Drives			
One or more of the	1.44-MB Diskette Drive		Χ	Χ
following depending on	Optical Drives			
	SATA CD-ROM Drive		Χ	Х
above)	SATA CD-RW/DVD-ROM Combo Drive		Χ	Χ
	SATA DVD-ROM Drive		Χ	Χ
	SATA DVD+/-RW (DL/DF) LightScribe Drive		Χ	Χ
	SATA DVD+/-RW (DL/DF) SuperMulti LightScribe Drive		Χ	Χ
	Slimline Optical Drives			
	PATA CD-ROM Slim Drive	Х		
	PATA CD-RW/DVD-ROM Combo Slim Drive	Χ		
	PATA DVD+/-RW Slim Drive	Χ		
	PATA DVD-ROM Slim Drive	Х		
Media Card Reader – One	HP 16-in-1 3.5" Media Card Reader w/ PCI card		Х	
of the following			-	Х



Standard Featu	ires and Configurable Components			
Security	Integrated 1.2 TPM Embedded Security Chip*	Х	Х	Χ
	Drive Lock	Χ	Χ	Χ
	HP ProtectTools Embedded Security Software	X	Χ	Χ
	Serial, Parallel, USB Enable/Disable (via BIOS)	X	Χ	Χ
	Removable Media Write/Boot Control	X	Χ	Χ
	Power-On Password (via BIOS)	Χ	Χ	Χ
	Setup Password (via BIOS)	Χ	Χ	Χ
	Solenoid Hood Lock / Sensor		Χ	Χ
	Hood Removal Sensor	Χ		
	* TPM module disabled where use is restricted by law; for example, Russia.			
NIC	Intel 82566DM Gigabit Network Connection (integrated on system board)	Х	Х	Х
	Intel PRO/1000 PT PCIe Gigabit NIC (full height bracket)			Χ
	Intel PRO/1000 PT PCIe Gigabit NIC (low profile bracket)		Χ	
	Broadcom NetXtreme Gigabit PCIe NIC (full height bracket)			Χ
	Broadcom NetXtreme Gigabit PCIe NIC (low profile bracket)	Χ*	Χ	
	* Requires optional PCIe riser card.			
Wireless	Wireless A+G PCI Card (full height bracket)	Х*	Х*	Х
	Wireless A+G PCI Card (low profile bracket)		Χ	
	* Requires optional PCI riser card.			
Modem	Agere 2006 PCI 56K International SoftModem (full height)	Х*	Х*	Х
	Agere 2006 PCI 56K International SoftModem (low profile)		Χ	
	* Requires optional PCI riser card.			



OuickSpecs

Quick3	HP Compaq dc7	700 B	usine	ss PC
Standard Featur	es and Configurable Components			
Graphics	Integrated Intel Graphics Media Accelerator 3000	Х	Χ	Х
•	DVI-D ADD2 SDV0 single head Graphics Adapter for USDT (PCIe x16)	Х		
	DVI-D ADD2 SDV0 single head low profile Graphics Adapter (PCIe x16)		Χ	
	DVI-D ADD2 SDVO single head full-height Graphics Adapter (PCIe x16)			Χ
	ATI Radeon X1300 (256MB SH) low profile PCIe Card, DVI w/TV	X*	Χ	
	ATI Radeon X1300 (256MB SH) full-height PCIe Card, DVI w/TV			Χ
	ATI Radeon X1300 Pro (256MB DH) low profile PCIe Graphics Card	X*	Χ	
	ATI Radeon X1300 Pro (256MB DH) full-height PCIe Graphics Card			Х
	ATI Radeon X1600XT (256MB DH) full-height PCIe Card, DVI w/TV-out			Х
	NVIDIA Quadro NVS 280 (64MB DH) PCI VGA Card	X**	X***	X***
	NVIDIA Quadro NVS 285 (128MB DH) PCIe x16 VGA Card	Х*	X***	X***
	* USDT requires optional PCIe riser card.			
	** USDT requires optional PCI riser card.			
	*** NVIDIA Quadro 285 and NVS 280 graphics cards can be			
	combined to provide support for four monitors.			
Audio	Integrated High Definition audio with Realtek 4-channel ALC262 codec (all ports are stereo)	Х	Х	Х
	Microphone and Headphone front ports	Χ	Χ	Χ
	Microphone rear port*			Χ
	Line-out and Line-In rear ports*	Χ	Χ	Χ
	Multistreaming capable*	Χ	Χ	Χ
	Internal Speaker	Χ	Χ	Χ
	* Rear audio ports are re-taskable as Line-in, Line-out, or Microphone-in. External sp powered externally. Multistreaming can be enabled in the Realtek control panel to al audio streams to be sent to/from the front and rear jacks. This allows for different as use separate audio ports on the system. For example, the front jacks could be used to communications application while the rear jacks are being used with external speaked application.	llow ind udio ap vith a h	lepende plication eadset	nt ns to for a
Input Devices	Keyboard – One of the following			
	HP PS/2 Standard Keyboard	Χ	Χ	Χ
	HP USB BG1650 Keyboard	Χ	Χ	Χ
	HP USB Standard Keyboard	Χ	Χ	Χ
	HP USB Smartcard Keyboard	Χ	Χ	Χ



Mouse - One of the following HP PS/2 2-Button Scroll Mouse

HP PS/2 2-Button Optical Scroll Mouse

HP USB 2-Button Optical Scroll Mouse

Χ

Χ

Χ

Χ

Χ

Χ

Χ

Χ

Χ

Standard Features and Configurable Components

Miscellaneous	HP FireWire / IEEE 1394 PCI Card (full height)	X*	X*	Χ
	HP FireWire / IEEE 1394 PCI Card (low profile)		Χ	
	PCI Express riser card – adds 1 low profile PCIe x16 slot	Х		
	PCI riser card – adds 1 full-height PCI slot	Х		
	PCI riser card – adds 2 full-height PCI slots NOTE: Low profile slots are unusable with riser card installed.		Х	
	PCI extender card for CMT (adds 2 PCI slots)			Χ
	PCI Serial and parallel I/O adapter	X**		
	2nd serial port adapter (full height)			Χ
	2nd serial port adapter (low profile)		Χ	
	Tower stand	Х	Χ	
	Configure dc7700 CMT in desktop orientation			Χ
	*Requires optional PCI riser card.			

^{**}Occupies same location as PCI riser card, so both cannot be used.

After-Market Options (availability may vary by region)

		USDT	SFF	CMT	After-Market Options Part Number
Communications	Wireless				•
	HP Wireless A+G PCI Card (North America only)	Χ*	Χ	Χ	EA118AA
	HP Wireless A+G PCI Card (WW except North America)	Χ*	Χ	Χ	PZ928AA
	HP BT450 USB Bluetooth Wireless Printer and PC Adapter NICs	Х	Χ	X	IPQ639A
	Broadcom NetXtreme Gigabit Ethernet PCIe NIC Card	X**	Χ	Χ	EA833AA
	Intel/PRO 1000 PT PCIe Gigabit NIC Card	X**	Χ	Χ	EH352AA
	Modem				
	Agere 2006 PCI 56K International SoftModem	Χ*	Χ	Χ	EK694AA
	* USDT requires optional PCI riser card. ** USDT requires optional PCIe riser card.				
Graphics	Single head solutions				
	HP ADD2 SDVO PCIe DVI-D Adapter (PCIe x16)	X**	Χ	Χ	DY674A
	ATI Radeon X1300 (256MB SH) PCIe Graphics Card	X**	Χ	Χ	AG392AA
	Multi head solutions				
	ATI Radeon X1300 Pro (256MB DH) PCIe Graphics Card	X**	Χ	Χ	AH050AA
	NVIDIA Quadro NVS 280 PCI Graphics Card (DMS59 DVI Dualhead Connector Cable)	Х*	Х	Х	DY599A
	NVIDIA Quadro NVS 285 (128MB DH) PCIe x16 VGA Card	X**	Χ	Χ	RD069AA
	HP DMS59 DVI Dual-head Connector Cable***		Χ	Χ	DL139A
	*Requires optional PCI riser card. ** USDT requires optional PCIe riser card. *** Requires NVIDIA Quadro NVS 280 PCI Graphics				
Hard Drives	Serial ATA Hard Drives				
	HP 80-GB SATA 3.0-Gb/s Hard Drive	Χ	Χ	Χ	PY276AA
	HP 160-GB SATA 3.0-Gb/s Hard Drive	Χ	Χ	Χ	PY277AA
	HP 250-GB SATA 3.0-Gb/s Hard Drive	Χ	Χ	Χ	PY278AA
	HP Removable SATA Hard Drive Enclosure (Frame & Carrier)		Χ	Χ	RY102AA
	HP Removable SATA Hard Drive Enclosure (Carrier Only)		Χ	Χ	RY103AA



Input/Output Devices	ns (availability may vary by region) Keyboards				
input/output Devices	-	v	v	v	DTE27A
	HP PS/2 Standard Keyboard	X	X	X	DT527A
	HP USB Standard Keyboard	Х	Х	Χ	DT528A
	Pointing Devices	.,		.,	22442
	HP PS/2 2-Button Scroll Mouse	X	X	X	DD440B
	HP PS/2 2-Button Optical Scroll Mouse	X	X	X	EY703AA
	HP USB 2-Button Optical Scroll Mouse	Х	X	X	DC172B
Memory (DIMMs)	PC2-5300 (DDR2 667-MHz) DIMMs Non-ECC				
	HP 2-GB PC2-5300 (DDR2 667-MHz) DIMM	Χ	Χ	Χ	PX977AA
	HP 1-GB PC2-5300 (DDR2 667-MHz) DIMM	Χ	Χ	Χ	PX976AA
	HP 512-MB PC2-5300 (DDR2 667-MHz) DIMM	Χ	Χ	Χ	PX975AA
	HP 256-MB PC2-5300 (DDR2 667-MHz) DIMM	Χ	Χ	Χ	PX974AA
	PC2-6400 (DDR2 800-MHz) DIMMs				
	HP 1-GB PC2-6400 (DDR2 800-MHz) DIMM	Χ	Χ	Χ	AH058AA
	HP 512-MB PC2-6400 (DDR2 800-MHz) DIMM	Χ	Χ	Χ	AH056AA
	HP 256-MB PC2-6400 (DDR2 800-MHz) DIMM	Χ	Χ	Χ	AH054AA
Monitors	TFTs				
	HP L1506 15 TFT Flat Panel Monitor – Analog only	Х	Χ	Х	PX848AA#ABA
	HP L1706 17 TFT Flat Panel Monitor – Analog only	Х	Χ	Х	PX849AA#ABA
	HP L1740 17 TFT Flat Panel Display – Analog/Digital	Х	Χ	Х	PL766AA#ABA
	HP L1755 17 TFT Flat Panel Display – Analog/Digital	Х	Χ	Χ	PL777AA#ABA
	HP L1906 19 TFT Flat Panel Display – Analog only	Х	Χ	Χ	PX850AA#ABA
	HP L1940T 19 TFT Flat Panel Display – Analog/Digital	Х	Χ	Χ	EM869AA#ABA
	HP L1955 19 TFT Flat Panel Display – Analog/Digital	Х	Χ	Χ	PD974AA#ABA
	HP L2065 20 TFT Flat Panel Display – Analog/Digital	Х	Χ	Χ	EF227A4#ABA
	HP LP2465 24 TFT Widescreen Flat Panel Display – Analog/Digital	Х	Χ	Χ	EF224A4#ABA
	CRTs				
	HP s7540 17 (16.0 vis) CRT Monitor	Х	Χ	Χ	PF997AA#ABA
	HP v7650 17 (16.0 vis) Flat-face CRT Monitor	Х	Χ	X	PF996AA#ABA
Multimedia	HP USB Powered Speakers	Х	Х	Х	RD628AA



After-Market Options	s (availability may vary by region)				
PATA Slim Optical Drives	DVD-ROM Drive				
	HP PATA DVD-ROM Slim Drive	Х			AH041AA
	Combo Drive				
	HP PATA CD-RW/DVD-ROM Combo Slim Drive DVD+/-RW Drive	X			AH042AA
	HP PATA DVD+/-RW (DL/DF) LightScribe Slim Drive	Х			AH043AA
SATA Half-Height Optical	DVD-ROM Drive				
Drives	HP SATA DVD-ROM Drive		Χ	Χ	AH047AA
	Combo Drive				
	HP SATA CD-RW/DVD-ROM Combo Drive		Χ	Х	AH046AA
	DVD+/-RW Drive HP SATA DVD+/-RW (DL/DF) LightScribe Drive		х	Х	AH048AA
Removable Storage	Diskette and Digital Drives				
- -	HP 1.44-MB External USB Diskette Drive	Х	Х	Х	DC141B
	HP 1.44-MB Internal Diskette Drive	٨	Х	X	DS710G
	Multimedia		^	A	557 100
	HP 16-in-1 Media Card Reader with PCI Card		Х	Χ	EM718AA
Security	Kensington Lock	Х	Х	Х	PC766A
•	HP Business PC Security Lock	Х	Х	Χ	PV606AA
	HP (USDT) Wall Mount Security Sleeve*	Х			PA719A
	HP (SFF) Wall Mount Security Sleeve**		Х		PA717A
	HP USB Smartcard Keyboard	Х	Х	Х	ED707AA
	* Dimensions (W x H x L): 12.7 x 3.5 x 12.0 inches; Weight: 3 ** Dimensions (W x H x L): 13.5 x 4.4 x 14.4 inches; Weight:				
Software	HP Client Configuration Manager, Premium Edition	Х	х	Х	T3488AA (use T3489AA for 1000 licenses)
	Altiris Client Management Suite Level 1 Includes:	Х	Χ	Χ	DR605A (use DR606A for
	Altiris Deployment Solution Altiris Inventory Solution Altiris Application Metering Solution Altiris Carbon Copy Solution				1000+ licenses)
	Altiris Software Delivery Solution Altiris Application Management Solution Altiris Patch Management Solution				



After-Market Options (availability may vary by region)					
Brackets/Stands	HP Integrated Work Center Stand	X			DL641B
	Tower Stand		Х		PS797A
Miscellaneous	HP Serial & Parallel IO Adapter	Х			PD825A
Accessories	HP 2nd Serial Port		Χ	Χ	PA716A
	HP (50 Pk) 5.25" Blank Bezel Kit		Χ	Χ	DC177B
	HP (USDT) PCI Riser Board	Х			ED247AA
	HP (USDT) PCIe x16 Riser Board	Χ			EU054AA
	HP (SFF) PCI Riser Board		Χ		PD824A
	HP PCI Extender			Χ	DC179B
	HP FireWire / IEEE 1394 PCI Card	X*	Χ	Χ	PA997A
	Belkin USB to Serial Adapter	X	Χ	Χ	EM449AA
	* Requires optional PCI riser card.				



Technical Specifications

Unit Environment and Operating	Ultra-slim Desktop	Small Form Factor	Convertible Minitower
Conditions			

General Unit Operating Guidelines

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's recirculated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Operating: 50° to 95° F (10° to 35° C)*		
Non-operating: -22° to 140° F(-30° to 60° C)		
Operating: 10% to 90% (non-condensing at ambient)		
Non-operating: 5% to 95% (non-condensing at ambient)		
Operating: 10,000 ft (3048 m)		
Non-operating: 30,000 ft (9144 m)		

* Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

Power Supply	Ultra-slim Desktop	Small Form Factor	Convertible Minitower
Power Supply	200 watt custom power supply – Active PFC)	240 watt custom power supply – Active PFC	365 watt custom power supply – Active PFC)
Operating Voltage Range	90 – 264 VAC	90 – 264 VAC	90 – 264 VAC
Rated Voltage Range	100 – 240 VAC	100 – 240 VAC	100 – 240 VAC
Rated Line Frequency	50/60 Hz	50/60 Hz	50/60 Hz
Operating Line Frequency Range	47 – 63 Hz	47 – 63 Hz	47 – 63 Hz
Rated Input Current	4A	4A	6A
Rated Input Current 80 PLUS*	N/A	3.5A	5A
System Heat Dissipation	Typical 300 btu/hr (76 kg-cal/hr) Maximum 1050 btu/hr (265 kg-cal/hr)	Typical 307 btu/hr (77 kg-cal/hr) Maximum 1260 btu/hr (318 kg-cal/hr	Typical 307 btu/hr (77 kg-cal/hr) Maximum 1916 btu/hr (483 kg-cal/hr)
System Heat Dissipation 80 PLUS* Power Supply	N/A	Typical 239 btu/hr (60 kg-cal/hr) Maximum 1024 btu/hr (258 kg-cal/hr	Typical 239 btu/hr (60 kg-cal/hr) Maximum 1557 btu/hr (392 kg-cal/hr)
Power Supply Fan	70mm variable speed	80mm variable speed	92mm variable speed
ENERGY STAR Compliant 80 PLUS* Power Supply	Х	Х	Х



Technical Specifications

FEMP Standby Power	Х	Х	Х
Compliant			
(<2W in S5 – Power Off)**			
Power Consumption in ES	< 3W	< 3W	< 3W
Mode – Suspend to RAM			
(S3) (Instantly Available PC)			

^{*} This 80% efficient power supply is a requirement for ENERGY STAR compliance in conjunction with a select range of processors and modules.

ROM BIOS Information

Key features of the HP BIOS in the dc7700 include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP Business desktop computer into the enterprise, such as PXE, remote configuration, remote control, and F10 Setup support for 12 languages. Select models offer Intel vPro technology including AMT (Active Management Technology).
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- Security HP BIOS Configuration for ProtectTools offers a robust and flexible set of security features to help the system administrator secure their systems from removal of sensitive data, and help prevent access by unauthorized users.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies to assist in
 operating the HP Business Desktop computer in any enterprise environment.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within DOS (Flashlite), BIOS updates from within Windows (HPQFlash, SSM), HP Client Manager, and fail-safe recovery. In addition, the HP Business Desktop BIOS Utilities tool enables replicated BIOS setup throughout the Enterprise; it is available from within the BIOS software and from the support website.

Additional HP BIOS Features

- Power-On password Helps prevent an unauthorized user from powering on the system. After a TPM Basic User password is established in windows, the user or admin can require TPM hardware based authentication during the power-on process.
- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the system
 configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be made to
 BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and configuration
 management, allowing operating systems and applications to manage power based on activity and usage. HP Compaq dc7700
 models use ACPI to provide power conservation features under Windows XP.



^{**} Power consumption in the Off/Apparent Off mode is measured and reported with the network interface controller "Wake on LAN" feature disabled in F10 Setup (default is "enabled").

Technical Specifications

Other Features	Description
ACPI-Ready Hardware	Advanced Configuration and Power Management Interface (ACPI).
	 Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
SMBIOS Ver. 2.5	System Management BIOS, for system management information
Wired for Management Support	Intel-driven, industry-wide initiative to make Intel architecture-based PCs, servers and mobile computers more inherently manageable right out of the box and over the network
Dual-State Power Button	Power button acts as both an on/off button and suspend-to-sleep button

Serviceability Features of System						
Dual Color Power LED on Front of Compu	Dual Color Power LED on Front of Computer (Indicates Normal Operations and Fault Conditions)					
	Number of 1-second red LED blinks followed by 2-second pause, then repeats: 2-processor thermal protection activated 3-processor not installed 4-power supply failure 5-memory error 6-video error 7-PCA failure (ROM detected failure prior to video) 8-invalid ROM, bootblock recover mode					
System/Emergency ROM	Flash ROM	 CMOS Battery Holder for easy Replacement 				
 Flash Recovery with Video Configuration Record SW 	5 Aux Power LED on System PCA	Processor ZIF Socket for easy Upgrade				
 Over-Temp Warning on Screen (Requires IM Agents) 	Clear Password Jumper	DIMM Connectors for easy Upgrade				
HP Backup and Recovery Manager	Clear CMOS Button	NIC LEDs (integrated) (Green & Amber)				

Serviceability Features of Chassis				
 Dual Color Power and HD LED – To Indicate Normal Operations and Fault Conditions 	Color coordinated cables and connectors	Tool-less Hood Removal		
Front power switch	 System memory can be upgraded without removing the system board or any internal components 	 Tool-less Hard Drive, CD & Diskette Removal 		
 Green Pull Tabs, and Quick Release Latches for easy Identification 		Tool-less System Board Removal		
NOTE: Thumb screw release mechanism	is used with the Ultra-slim Desktop chassis cove	er.		
Factoria	Description			
Feature Description				
AMT 2.0 support (Active Management Technology)	Select models offer new Intel vPro Technology utilizing AMT 2.0 for network alerting and management of systems regardless of power state, as well as operating system-absent environments.			



Technical Specifications

ASF 2.0 support (Alert Standard Format)	Industry-standard specification for network alerting in operating system-absent environments		
Tower	Product can be oriented as a tower (in addition to desktop orientation)		
Drive Lock*	Implementation of the industry standard ATA Security feature set. When enabled, it prevents software access to user data on the drive until one or two user-defined passwords are provided.		
Drive Self Tests (DPS)* DPS Access through F10 Setup during Boot	 Drive Protection System A diagnostic hard drive self test. It scans critical physical components and every sector of the hard drive for physical faults and then reports any faults to the user. Running independently of the operating system, it can be accessed through a Windows-based diagnostics utility or through the computer's setup procedure. It produces an evaluation on whether the hard drive is the source of the problem and needs to be replaced. The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain types of failures. 		
SMART Technology* (Self-Monitoring, Analysis and Reporting Technology)	Allows hard drives to monitor their own health and to raise flags if imminent failures were predicted		
SMART I – Drive Failure Prediction	Predicts failures before they occur. Tracks fault prediction and failure indication		
SMART II – Off-Line Data Collection	parameters such as re-allocated sector count, spin retry count, calibration retry cou		
SMART III – Off-Line Read Scanning with Defect Reallocation	 By avoiding actual hard drive failures, SMART hard drives act as "insurance" against unplanned user downtime and potential data loss from hard drive failure 		
* This feature is inoperable when a RAID	(Redundant Array of Independent Disks) configuration is enabled.		



Technical Specifications - Audio

High Definition Audio

Type Integrated

High Definition Stereo

Codec

Yes - Realtek ALC262, 4-channel

Audio Jacks Microphone-In (64-K ohm Input Impedance); front and rear stereo analog

microphone ports available except for USDT and SFF, which has front stereo

microphone only

Line-In (64-K ohm Input Impedance)

Line-Out * (200 ohms Output Impedance, expects at least a 10-K ohm load) Headphone-Out (1 Ohm Output Impedance, expects at least a 32 ohm load)

* Internal Speaker Amplifier is for Internal Speaker only. External Speakers need to be powered externally. Rear audio ports are re-taskable as Line-in, Line-out, or Microphone-in.

Multistreaming Capable Multistreaming can be enabled in the Realtek control panel to allow

independent audio streams to be sent to/from the front and rear jacks.

Sampling 8 kHz – 192 kHz

Wavetable Syntheses

(software)

Yes – Uses OS soft wavetable

Stereo (Left & Right channels)

Analog Audio Yes

Number of Channels on

Line-Out (mono/stereo)

Internal Audio Speaker 1.5 W

Power Rating

Internal Speaker Yes
External Speaker Jack Yes

(Line-Out)



Technical Specifications - Communications

Integrated Intel 82566DM Connector Gigabit Network Controller

Connection

Connector RJ-45

Controller Intel Nineveh Gigabit platform LAN Connect Networking Controller

Memory Integrated 96KbB on chip buffer memory

Data rates supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3 ab and 802.3u compliant,

Bus architecture GLCI, LCI interface. Intel specific MAC to PHY interface

Data transfer mode At gigabit GLCI (802.3 serdes) is for Data, LCI (parallel bus)for MDIO, at 10/100

LCI for both data and MDIO, GLCI is idle.

Hardware certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for

European Union

Power requirement Require 3.3Vaux,1.8V and 1.0V or just 3.3V with integrated regulators

Power consumption 1.16 Watts for 82566, whole LOM 2.53 Watts

ACBS Intel Auto Connect Battery Saving feature

Boot ROM support Yes

Network transfer mode Full-duplex

Half-duplex (not available for the 1000BASE-T transceiver)

Network transfer rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Environmental Operating temperature 32° to 131°F (0° to 55° C)

To 70° C for external regulator

Operating humidity 85% at 131° F (55° C)

Management capabilities WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable

diagnostic.

Alerting ASF 2.0 support, AMT 2.0 support on dc7700p models with Intel vPro

Technology

Technical Specifications - Communications

Intel PRO/1000 PT PCIe **Gigabit NIC**

Connector RJ-45

Intel 82572EI Gigabit Ethernet Controller Controller

Integrated Dual 48K configurable transmit receive FIFO Buffers Memory

Data rates supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant, 802.3x

flow control

PCI-E 1.0a **Bus architecture**

Data transfer mode **Bus-master DMA**

Hardware certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for

European Union

Power requirement Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

Boot ROM support Yes

Network transfer rate 10BASE-T (half-duplex) 10 Mbps

> 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps

1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI Bus) 32° to 131°F (0° to 55° C)

Environmental Operating temperature

> **Operating humidity** 85% at 131° F (55° C)

Dimensions 6.4 x 2.6 x 0.8 in (16.3 x 6.6 x 1.9 cm)

Management capabilities ASF, WOL, PXE, DMI, WFM 2.0.

Broadcom NetXtreme Gigabit Ethernet PCIe NIC Card

Connector **RJ-45**

Controller Broadcom 5751 PCI-Express LAN Controller Memory Integrated 96Kb frame buffer memory

Data rates supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB and 802.3u compliant, 802.3x

flow control

Bus architecture PCI-E

Data path width Single channel, PCI-E Data transfer mode **Bus-master DMA**

Hardware certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for

European Union

Power requirement 3.1 watts @ +3.3V AUX supply with 5V tolerance

Boot ROM support Yes

Network transfer mode Full-duplex

Half-duplex (not available for the 1000BASE-T transceiver)



Technical Specifications - Communications

Network transfer rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps

1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI Bus)

Environmental Operating temperature 32° to 131°F (0° to 55° C)

Operating humidity 85% at 131° F (55° C)

Dimensions 4.4 x 2.2 x 0.08 in (11.2 x 5.5 x 2 cm)

Operating system driver Microsoft® Windows® NT® 4.0, Microsoft Windows 98, Microsoft 2000,

support Microsoft XP, Linux 2.2, Linux 2.4

ipport Therosore Art, Emax E.E., Emax E.

Management capabilities ACPI, WOL and DMI 2.0, PXE 2.0, WfM 2.0, Broadcom mgmt utility

Alerting ASF 2.0

HP Wireless A+G PCI

Dimensions 4.99 x 2.54 x 0.71 in (126.8 x 64.4 x 18.0 mm)

Weight 0.268 lb (65 g)

Controller Atheros AR5414X chipset

system interface PCI Spec 2.2

 Network standard
 IEEE 802.11a/b/g

 Frequency band
 5.1500 to 5.8500 GHz

 2.4000 to 2.4835 GHz

2.4465 to 2.4835 GHz (Europe, Middle East, Asia and Asia Pacific - excluding

Japan)

2.4000 to 2.4697 GHz (Japan)

Operating temperature 32° to 140° F (0° to 60° C), operating

Storage temperature -4° to 176° F (-20° to 80° C), non-operating

Humidity 10% to 85% non-condensing

Operating voltage $5V \pm 5\%$

Power consumption Tx/Rx peak 560/250mA @ 3.3V (max.)

Output power 15 dBM ±2dB

(approximately)

Receive sensitivity -90dBm at 11 Mbps (typical)

Data transfer rate Standard rates of 1, 2, 5.5, 11, 6, 9, 12, 18, 24, 48, 54 and Super AG Mode108-

Mbps

Spreading DSSS (Direct Sequence Spread Spectrum)

Security 64(40h) bit, 128(104h) bit, WPA, IEEE802.1X, AES-OCB, AES-CCM, Microsoft

PEAP, TKIP, WEP.

Antenna External 5dBi antenna

Throughput 108 Mbps (only with Belkin 54G or 200 ft (60.96 m) – Indoor

above router that supports 108 Mbps

speed)

54 Mbps 200 ft (60.96 m) – Indoor



Technical Specifications - Communications

11 Mbps 200 ft (60.96 m) - Indoor

Certifications Wi-Fi certified

Certifications for use by

country

North America: United States, Canada

Europe: Austria, Belgium, Cyprus, Denmark, Finland, France, Germany, Greece, Iceland, Ireland, Italy, Liechtenstein, Luxembourg, Netherlands, Norway,

Portugal, Spain, Sweden, Switzerland, United Kingdom

Australia New Zealand

Agere 2006 PCI 56K International SoftModem **Data Transmission** Technology speeds: 56,000 Kbps maximum downstream data, controllerless

NOTE: 56 Kbps technology refers to download speeds only and requires compatible modems at server sites. Other conditions may limit modem speed. FCC limitations allow a maximum of 53 Kbps during download transmissions.

Data Speeds (Upload only)

33,600/31,200/28,800/26,400/21,600/19,200/16,800/14,400/12,000/

9.600/7,200/4,800/2,400/1,200/300

Data Standards ITU-T V.90, ITU-T, ITU-T V.34, V.44, V.42, V.42bis21, V.32bis, Bell 212A, and

Bell 103

Fax Speeds 14.400/12.000/9.600/7.200/4.800/2.400/1.200/300 b/s **Fax Mode Capabilities** ITU-T T.31 class 1 FAX, V. 17, V.29, V.27ter, and V.21 Channel 2

Compression

Error Correction and Data V.44, 42bis, V.42 and MNP2-5

Power Management ACPI; PPMI 1.1 and wake support with PME and Vaux; meets PCI 2.3

requirements and PC 2001 requirements

Upgradeability Driver upgradeable for future enhancements

Video ITU-T V.80 video ready interface

Other TIA/EIA 602 standard AT command set

Integrated DTE interface with speeds of up to 115.2 Kbps, parallel 16550a

UART-compatible interface Optional ring wakeup signal

Operating Temperature 32° to 158° F (0° to 70° C) **Operating Humidity** 20% to 90%, non-condensing

Power Requires a 3.3-V auxiliary power rail on PCI bus

Uses only one PCI load (i.e., one grant/request pair), one shared IRQ, one

electrical load

Chipset Agere Systems SV92PL – Integrated PCI interface with 5-V tolerant buffers

and CardBus support

Dimensions (L X H) Complies with PCI low profile specifications-6.7 x 2.3 in (17.0 x 5.8 cm) and

supports high- and low-profile brackets

Connection Single RJ-11 connector

Other Features Digital line protection, call progress monitoring via on-board piezo device,

support for high profile and low profile brackets, PnP ID support

Technical Specifications - Communications

Safety UL recognized to UL 1950, 3rd edition (U.S. and Canada); IEC 950 (TUV, NEMKO,

DEMKO, SEMKO); CE Mark, EC 950 (TUV, NEMKO, DEMKO, SEMKO, CE mark

EMC FCC Part 15, IC ES003, EN 55022, 3rd edition, EN 55024, annex A, EN 61000-4-

6, EN 61000-4-8

Telecom FCC Part 68, IC-CS-03 (Canada); Worldwide PTT approvals

Not available in Korea or the Republic of South Africa.

Health Bare PCB material compliant to 94V-0 or better (marked as such)

Other PC 2001 compliant, PCI version 2.3, WHQL approved; ACPI compliant



Technical Specifications - Graphics

Integrated	Graphics
Media Acce	lerator 3000

3D/2D Controller Microsoft DirectX® 9 based with support for Pixel Shader 2.0, 4:1 anisotropic

filtering, Gaussian texture filtering, shadow maps, volumetric textures,

double-sided stencil buffers, and 4 pixel pipes.

VGA Controller Integrated

Bus Type PCI Express™ x16 (If an external graphics card is installed in a PCI slot, the

internal graphics can be enabled or disabled using the system's BIOS setup utility. If an external graphics card is installed in the PCI Express™ slot, the

internal graphics cannot be enabled).

RAMDAC Integrated, 400 MHz

Memory Graphics memory is shared with system memory. Graphics memory usage

> varies depending on the amount of system memory installed and system load. 8 MB is pre-allocated for graphics use at system boot time. Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and

system memory use.

System memory equal or greater than 512 MB

8 MB pre-allocated + 248 MB DVMT = max frame buffer of 256 MB

Controller Clock Speed

400 MHz

Overlay Planes

Single overlay support with 5x3 filtering

Maximum Color Depth

32 bits/pixel

Maximum Vertical Refresh Rate

85 Hz at up to 1920x1440, 85 Hz at 2048x1536. Varies with mode and

configuration. See table below.

Multi-display Support

Support for one CRT via the motherboard's VGA connector. Support for an additional DVI-D display via the optional DVI ADD2 card. Dual independent

displays and dual synchronous (Twin or Clone mode) displays are supported.

Graphics/Video API

Support

Microsoft DirectX®9, DirectXVA®, VMR9, GDI/GDI+; OpenGL® 1.4.

Resolutions Supported ¹	Resolution	Maximum Refresh Rate (Hz)	
		Analog Monitor	Digital Monitor
	640 x 480	85	60
	800 x 600	85	60
	1024 x 768	85	60
	1280 x 1024	85	60
	1600 x 1200	85	60
	1920 x 1080	85	60
	1920 x 1200	85	60
	1920 x 1440	85	60
	2048 x 1536	85	60

¹ Modes listed are supported with a single active display. The supported mode list for multiple active displays is a subset of this list. Not all modes will support video playback and some supported modes may use software MC (motion compensation) rather than hardware MC. Not all modes will support 3D acceleration depending on the system configuration (e.g., resolution selected, size of frame buffer, number of installed memory modules, etc.).

NOTE: Other resolutions and refresh rates may be selectable but are not recommended.



Technical Specifications - Graphics

DVI ADD2 Graphics

Models DY674A Intel DVI ADD2 adapter

Form Factor Low-profile card

DVI-D Connector Compliant with DDWG (Digital Display Working Group) and VESA specifications

for a single-link digital DVI (DVI-D) connector.

Dual Head Support Yes, when used with the integrated VGA connector

 Display Devices
 HP L1530

 Supported
 HP L1740

 HP L1755
 HP L1940

HP L1955 HP L2035 HP L2335

NOTE: The DVI ADD2 card offers optimal performance with any display that meets applicable VESA standards.

Color Depth All modes support 8-bpp, 16-bpp, and 24-bpp color depths

Host Interface Connector Mechanically compliant with PCI-E standard

Complies with the Intel ADD2 and Intel Serial Digital Video Output (SDVO)

specifications

Dot Clock 165 MHz maximum

Display Modes Supports display modes that require up to 165-MHz bandwidth on the link, as

shown in the following table.

Resolution		60-Hz LCD	60-Hz	75-Hz	85-Hz
Blanking		5% reduced	GTF	GTF	GTF
640 x 480	VGA	Yes	Yes	Yes	Yes
800 x 600	SVGA	Yes	Yes	Yes	Yes
1024 x 768	XGA	Yes	Yes	Yes	Yes
1280 x 1024	SXGA	Yes	Yes	No	No
1600 x 1200	UXGA	Yes	Yes	No	No



Technical Specifications - Graphics

ATI Radeon X1300 (256MB Bus Type SH) PCIe Graphics Card

PCI Express (x16 lanes)

Maximum Vertical

Refresh Rate

Display Support Integrated 400 MHz RAMDAC

85 Hz

Display Max Resolution 2048 x 1536 **Board Display Options** DVI-I + TV

DVI-I supports analog CRT or flat panel or digital flat panel (using DVI-A, DVI-D

or DVI-I connector)

DVI-I supports analog CRT or flat panel (with VGA connector and DVI-I to VGA

dongle)

TV connector is a 4-pin mini-DIN S-video connector

Board Configuration 128 MB Frame Buffer **Specification** Description **Graphics Chip RV515** Core clock 450 MHz Memory clock 250 MHz Frame buffer **256 MB DDR2**

Languages supported

24 languages: English, Arabic, Chinese Simplified, Chinese Traditional, Czechoslovakian, Danish, Dutch, Finnish, French, German, Greek, Hebrew, Hungarian, Italian, Japanese, Korean, Norwegian, Polish, Portuguese, Russian,

Spanish, Swedish, Thai, Turkish

Core Power

25 W (Max board power)

Option kit contents

- ATI RADEON X1300 PCIe graphics card with full height bracket attached
- Low profile bracket DVI-to-VGA Adapter
- Software CD with graphics drivers
- Warranty documentation

Compliance standards

EMC Emissions:

a) FCC Part 15, Subpart B – Unintentional Radiators, Class B Computing

Devices for Home & Office Use

b) CISPR22: 1997/EN 55022:1998 - Class B - Limits and methods of measurement of radio disturbance characteristics of Information Technology

Equipment

c) Canadian Standard ICES-003 is equivalent to CISPR22

d) Taiwanese Standard BSMI

e) Japanese VCCI f) Australian C-Tick

EMC Immunity:

CISPR 24:1997/EN 55024:1998 – Information Technology Equipment -Immunity Characteristics – Limits and Methods of Measurement.

Safety:

UL 60950 (USA) & EN 60950 (EU): Safety of Information Technology Equipment, Including Electrical Business Equipment. All boards meet UL PCB flammability requirements.



Technical Specifications - Graphics

ATI Radeon X1300 Pro (256MB DH) PCIe Graphics Card

Bus Type PCI Express (x16 lanes)

Maximum Vertical Refresh Rate 85 Hz

Display Support Integrated 400 MHz RAMDAC

Display Max Resolution 2048 x 1536

Board Display Options Supports 2 displays via included DMS-59 to dual VGA cable or 2 DVI monitors

via optional DMS-59 to dual DVI monitor kit #DL139A. Support TV connection via 7 pin mini Din S-video connector

Board Configuration

128 MB Frame Buffer Gra

SpecificationDescriptionGraphics ChipRV516Core clock600 MHzMemory clock400 MHz

Frame buffer 256 MB DDR2 (128 bits wide)

Languages supported

24 languages: English, Arabic, Chinese Simplified, Chinese Traditional, Czechoslovakian, Danish, Dutch, Finnish, French, German, Greek, Hebrew, Hungarian, Italian, Japanese, Korean, Norwegian, Polish, Portuguese, Russian, Spanish, Swedish, Thai, Turkish

Core Power

25 W (Max board power)

Option kit contents

- ATI Radeon X1300 Pro (256MB DH) PCIe Graphics Card with full height bracket attached
- DMS-59 Dual VGA

NOTE: The Optional DMS-59 DVI cable can be ordered with HP Option Kit #DL139A

- Software CD with graphics drivers
- Low profile bracket to convert the card for using in a low profile chassis
- Warranty documentation

Compliance standards

EMC Emissions:

a) FCC Part 15, Subpart B – Unintentional Radiators, Class B Computing Devices for Home & Office Use

b) CISPR22: 1997/EN 55022:1998 – Class B – Limits and methods of measurement of radio disturbance characteristics of Information Technology Equipment

- c) Canadian Standard ICES-003 is equivalent to CISPR22
- d) Taiwanese Standard BSMI
- e) Japanese VCCI
- f) Australian C-Tick
- g) Korean (MIC)

EMC Immunity:

CISPR 24:1997/EN 55024:1998 – Information Technology Equipment – Immunity Characteristics – Limits and Methods of Measurement.

Safety:

UL 60950 (USA) & EN 60950 (EU): Safety of Information Technology Equipment, Including Electrical Business Equipment. All boards meet UL PCB flammability requirements.



MB DH) FH PCIe Graphics

Technical Specifications - Graphics

ATI RADEON X1600XT (256 Bus Type

Card

PCI Express (x16 lanes)

Maximum Vertical

Refresh Rate
Display Support

Integrated 400 MHz RAMDAC

Display Max Resolution 2560 x 1600 digital, 2048 x 1536 analog

85 Hz

Board Display Options 2 DVI-I ports (one port supports dual link DVI). DVI-I supports an analog CRT or

flat panel with a VGA connector via the provided DVI-I to VGA adapter

4-pin mini-DIN S-video connector for TV output

Board Configuration Specification Description

Graphics chip RV530
Core clock 590 MHz
Memory clock 690 MHz

Frame buffer 256 MB GDDR3, 128 bit wide

Core Power 56 W (Max board power)

NVIDIA Quadro NVS 280 64MB PCI Dual Head **Form Factor** Low profile (both ATX and low profile brackets included)

Graphic Controller Integrated Quadro 280 2-D graphics processor unit (GPU)

Bus type PCI

RAMDAC Dual 350 MHz integrated

Memory 64 MB DDR with frame buffer and Texture storage

Connector Single High-density DMS-59 Connector

Dimensions Low-profile, 2.586 x 6.6 in (6.57 x 16.76 cm)

Controller clock speed 250 MHz

Color depth 32-bits/pixel max

Overlay planes One 16-bit Video overlay plane

Maximum vertical refresh 85 Hz

rate

Multi-monitor support Dual analog or digital monitors

Dual DVI Support Yes (with kit DL139A)

High-definition Video Fu

Full-screen, full-frame video playback of HDTV and DVD content

Processor (HDVP) DVD-ready motion compensation for MPEG-2

Independent hardware color controls for video overlay Hardware color-space conversion (YUV 4:2:2 and 4:2:0)

IDCT motion compensation

Available graphics drivers Microsoft Windows 2000 and Microsoft Windows XP (Provides full native

Dual View mode, Span or Big Desktop mode, and Clone mode)

NOTE: HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/eng/software_drivers.html.



Technical Specifications - Graphics

Analog Resolution	Maximum Refresh Rate
640 x 480	240 Hz
800 x 600	240 Hz
1024 x 768	200 Hz
1600 x 1200	170 Hz
1600 x 1200	150 Hz
1600 x 1200	100 Hz
1920 x 1200	85 Hz
1920 x 1200	85 Hz
1920 x 1440	75 Hz
2048 x 1536	60 Hz
Digital Resolution	Maximum Refresh Rate
640 x 480	75 Hz
800 x 600	75 Hz
1024 x 768	75 Hz
1152 x 864	60 Hz
1280 x 1024	60 Hz
1600 x 1200	60 Hz (primary only)

NVIDIA Quadro NVS 285 (128MB DH) PCIe x16 Graphics Card Form Factor Low profile, both ATX and low profile brackets included

Graphic Controller Integrated Quadro 285 2D graphics processor unit (GPU)

Bus Type PCI-Express

Memory 128 MB DDR (64 MB local frame buffer plus 64 MB of system memory via

TurboCache)

Connector DMS-59 to dual-DVI Y-cable or dual-VGA Y-cable **Dimensions** Low-profile, 2.586 x 6.6 in (6.57 x 16.76 cm)

Multi-monitor SupportDual analog or digital monitorsRAMDACDual 350 MHz (integrated)

Maximum Pixel Clock 350 MHz

Overlay Planes One 16-bit Video overlay plane

High-definition Video Full screen, full frame video playback of HDTV and DVD content **Processor** (HDVP) DVD-ready motion compensation for MPEG-2

Independent hardware color controls for video overlay Hardware color-space conversion (YUV 4:2:2 and 4:2:0)

IDCT motion compensation

5-tap horizontal by 3-tap vertical filtering

8:1 up/down scaling

Available Graphics

Drivers

Microsoft Windows 2000 and Microsoft Windows XP (Provides full native Dual

View mode, Span or Big Desktop mode, and Clone mode)

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://www.hp.com/country/us/en/support.html?pageDisplay=drivers



Technical Specifications - Graphics

Analog Resolution	Maximum Refresh Rate
640 x 480	240 Hz
800 x 600	240 Hz
1024 x 768	240 Hz
1152 x 864	170 Hz
1280 x 1024	150 Hz
1600 x 1200	100 Hz
1920 x 1080	85 Hz
1920 x 1200	85 Hz
1920 x 1440	75 Hz
2048 x 1536	60 Hz
Digital Resolution	Maximum Refresh Rate
640 x 480	75 Hz
800 x 600	75 Hz
1024 x 768	75 Hz
1152 x 864	60 Hz
1280 x 1024	60 Hz
1600 x 1200	60 Hz
1900 x 1200	60 Hz



Technical Specifications - Hard Drives

7200 rpm Serial ATA Hard 250-GB Drives

Capacity 250,059,350,016 bytes

Height 1 in (2.54 cm)

Width Media diameter: 3.5 in (8.89 cm)

Physical size: 4 in (10.2 cm)

Interface Serial ATA (3.0 Gb/s)

Synchronous Transfer

Rate (Maximum)

Up to 3 Gb/s

Buffer 8 MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average1.0 msAverage
Full-Stroke8.5 ms18 ms

Rotational Speed 7,200 rpm Logical Blocks 488,397,168

Operating Temperature 41° to 131° F (5° to 55° C)

160-GB Capacity 163,928,604,672 bytes

Height 1 in (2.54 cm)

Width Media diameter: 3.5 in (8.89 cm)

Physical size: 4 in (10.2 cm)

0.9 ms

9.3 ms

18 ms

Interface Serial ATA (3.0 Gb/s)

Synchronous Transfer

Rate (Maximum)

Up to 3 Gb/s

Buffer 8 MB

Seek Time (typical reads, includes controller overhead, including settling)

Single Track

Average

Full-Stroke

Rotational Speed 7,200 rpm **Logical Blocks** 320,173,056

Operating Temperature 41° to 131° F (5° to 55° C)



Technical Specifications - Hard Drives

80-GB Capacity 80,026,361,856 bytes

> Height 1 in (2.54 cm)

Width Media diameter: 3.5 in (8.89 cm)

Physical size: 4 in (10.2 cm)

Serial ATA (3.0 Gb/s) Interface

Synchronous Transfer

Rate (Maximum)

Buffer 8 MB

Single Track Seek Time (typical reads, 2.0 ms includes controller Average 9.3 ms overhead, including **Full-Stroke** 21 ms

Up to 3 Gb/s

settling) **Rotational Speed** 7,200 rpm

Logical Blocks 156,301,488

Operating Temperature 41° to 131° F (5° to 55° C)

10,000 RPM Serial ATA

160-GB

Hard Drives

Capacity 160,041,885,696 bytes

Height 1 in (2.54 cm)

Width Media diameter: 3.0 in (7.62 cm)

Physical size: 4 in (10.2 cm)

Interface Serial ATA (1.5 Gb/s), Native Command Queuing enabled

Synchronous Transfer

Rate (Maximum)

Cache 16 Mbytes

Seek Time (typical reads, **Single Track** 0.3 ms includes controller **Average** 4.6 ms overhead, including **Full-Stroke** 10.2 ms settling)

Up to 1.5 Gb/s

Rotational Speed 10,000 RPM **Logical Blocks** 312,581,808

Operating Temperature 41° to 131° F (5° to 55° C)



Technical Specifications - Hard Drives

80-GB Capacity 80,026,361,856 bytes

Height 1 in (2.54 cm)

Width Media diameter: 3.0 in (7.62 cm)

Physical size: 4 in (10.2 cm)

Interface Serial ATA (1.5 Gb/s), Native Command Queuing enabled

Synchronous Transfer

Rate (Maximum)

Up to 1.5 Gb/s

Cache 16 Mbytes

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.3 msAverage
Full-Stroke4.6 ms

Rotational Speed 10,000 RPM **Logical Blocks** 156,301,488

Operating Temperature 41° to 131° F (5° to 55° C)



Technical Specifications - Input/Output Devices

USB Standard Keyboard	Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)
		Dimensions (L \times W \times H)	18.0 x 6.4 x 0.98 in (45.8 x 16.3 x 2.5 cm)
		Weight	2 lb (0.9 kg) minimum
	Electrical	Operating voltage	+ 5VDC ± 5%
		Power consumption	50-mA maximum (with three LEDs ON)
		System interface	USB Type A plug connector
		ESD	CE level 4, 15-kV air discharge
		EMI – RFI	Conforms to FCC rules for a Class B computing device
		Microsoft® PC 99 – 2001	Functionally compliant
	Mechanical	Languages	38 available
		Keycaps	Low-profile design
		Switch actuation	55-g nominal peak force with tactile feedback
		Switch life	20 million keystrokes (using Hasco modified tester)
		Switch type	Contamination-resistant switch membrane
		Key-leveling mechanisms	For all double-wide and greater-length keys
		Cable length	6 ft (1.8 m)
		Microsoft PC 99 – 2001	Mechanically compliant
		Acoustics	43-dBA maximum sound pressure level
	Environmental	Operating temperature	50° to 122° F (10° to 50° C)
		Non-operating temperature	-22° to 140° F (-30° to 60° C)
		Operating humidity	10% to 90% (non-condensing at ambient)
		Non-operating humidity	20% to 80% (non-condensing at ambient)
		Operating shock	40 g, six surfaces
		Non-operating shock	80 g, six surfaces
		Operating vibration	2-g peak acceleration
		Non-operating vibration	4-g peak acceleration
		Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
		Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence
	Approvals	UL, CSA, FCC, CE Mark, TUV,	TUV GS, VCCI, BSMI, C-Tick, MIC
	Ergonomic compliance	ance ANSI HFS 100, ISO 9241-4, and TUVGS	
	Kit contents	Keyboard, installation guid	e, warranty card, safety and comfort guide



Technical Specifications - Input/Output Devices

-,		Form factor	USB basic Smart Card keyboard	
HP USB Smartcard Keyboard	Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)	
	Kit contents	Keyboard, keyboard software media, installation guide, warrar and comfort guide		
	Ergonomic compliance	ANSI HFS 100, ISO 9241-4,	and TUVGS	
	Approvals	UL, CSA, FCC, CE Mark, TUV,	TUV GS, VCCI, BSMI, C-Tick, MIC	
		Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence	
		Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
		Non-operating vibration	4-g peak acceleration	
		Operating vibration	2-g peak acceleration	
		Non-operating shock	80 g, six surfaces	
		Operating shock	40 g, six surfaces	
		Non-operating humidity	20% to 80% (non-condensing at ambient)	
		Operating humidity	10% to 90% (non-condensing at ambient)	
		Non-operating temperature	-22° to 140° F (-30° to 60° C)	
	Environmental	Operating temperature	50° to 122° F (10° to 50° C)	
		Acoustics	43-dBA maximum sound pressure level	
		Microsoft PC 99 – 2001	Mechanically compliant	
		Cable length	6 ft (1.8 m)	
			For all double-wide and greater-length keys	
		Switch type	Contamination-resistant switch membrane	
		Switch life	20 million keystrokes (using Hasco modified tester)	
		Switch actuation	55-g nominal peak force with tactile feedback	
		Keycaps	Low-profile design	
	Mechanical	Languages	38 available	
		Microsoft PC 99 – 2001	Functionally compliant	
		EMI – RFI	Conforms to FCC rules for a Class B computing device	
		ESD	CE level 4, 15-kV air discharge	
		System interface	PS/2 6-pin mini din connector	
		Power consumption	50-mA maximum (with three LEDs ON)	
	Electrical	Operating voltage	+ 5VDC ± 5%	
		Weight	2 lb (0.9 kg) minimum	
		Dimensions (L x W x H)	18.0 x 6.4 x 0.98 in (45.8 x 16.3 x 2.5 cm)	
PS/2 Standard Keyboard	Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)	



Technical Specifications - Input/Output Devices

Colors Carbonite/Silver

Dimensions (H x W x D) 18.2 x 6.3 x 1.3 in (46.3 x 16.1 x 3.3 cm)

Weight 2 lb (0.9 kg) minimum

Electrical Operating voltage + 5VDC ± 5%

Power consumption 100-mA maximum (with four LEDs ON)

System interface USB Type A plug connector ESD CE level 4, 15-kV air discharge

EMI – RFI Conforms to FCC rules for a Class B computing

device

Microsoft PC 99 – 2001 Functionally compliant

Mechanical Languages 30+ available

Keycaps Low-profile design

Switch actuation55 g nominal peak force with tactile feedbackSwitch life20 million keystrokes (using Hasco modified

tester)

Switch type Contamination-resistant membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Environmental Operating temperature 50° to 122° F (10° to 50° C)

Non-operating -22° to 140° F (-30° to 60° C)

temperature

Operating humidity 10% to 90% (non-condensing at ambient) **Non-operating humidity** 20% to 80% (non-condensing at ambient)

Operating shock40 g, six surfacesNon-operating shock80 g, six surfacesOperating vibration2-g peak accelerationNon-operating vibration4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence **Drop** (in box) 42 in (107 cm) on concrete, 16-drop sequence

SMARTCARD function Support All ISO 7816 smart cards

Interface Reads from and writes to all ISO7816-1, 2, 3, 4

memory and microprocessor smart cards (T=0,

T=1)

Chipset SCM STCII

Standard APIs supported PC/SC, EMV2000, SET

Technical Specifications - Input/Output Devices

Power	USB Port

Short circuit detection (protects smart card and

reader)

Power supply compliant with ISO7816 and EMV

(5V, 60 mA)

Supports 3-V and 5-V cards

Power consumption 250-mA maximum draw (50 mA for the keyboard

with three LEDs ON and 200-mA maximum startup current using a high-current, 60-mA

smart card)

Communication From card Programmable from

9,600 baud to 115,200

baud

From computer Up to 38,400 baud

Landing mechanism Contact device Friction contact

Card insertions rating Up to 100,000 insertion

cycles

Interface modes USB communications through USB port

SCM protocol

USB connection

Automatic card insertion/removal detection

Reader performance

Electro-magnetic

interface

Europe 89/336/CEE guideline

standards USA USAFCC part 15

USB Standard BG1650 Keyboard (gray) Physical characteristics

Keys

104, 105, 106, 107, 109 layout (depending upon

country)

Dimensions (L x W x H)

18.0 x 6.4 x 0.98 in (45.8 x 16.3 x 2. 5 cm)

Weight

2 lb (0.9 kg) minimum

Electrical

Operating voltage

+ 5VDC ± 5%

Power consumption

50-mA maximum (with three LEDs ON)

System interface

USB Type A plug connector

ESD

CE level 4, 15-kV air discharge

EMI – RFI

Switch life

Conforms to FCC rules for a Class B computing

20 million keystrokes (using Hasco modified

device

Microsoft PC 99 – 2001

Functionally compliant

Mechanical

Languages 38 available

Keycaps Low-profile design

Switch actuation 55-g nominal peak force with tactile feedback

tester)

Switch type Contamination-resistant switch membrane

Key-leveling mechanisms For all double-wide and greater-length keys



Technical Specifications - Input/Output Devices

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Environmental Operating temperature 50° to 122° F (10° to 50° C)

-22° to 140° F (-30° to 60° C) Non-operating

temperature

Operating humidity 10% to 90% (non-condensing at ambient) Non-operating humidity 20% to 80% (non-condensing at ambient)

Operating shock 40 g, six surfaces Non-operating shock 80 g, six surfaces **Operating vibration** 2-g peak acceleration Non-operating vibration 4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence 42 in (107 cm) on concrete, 16-drop sequence **Drop** (in box)

Approvals

UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC, BG Prufzert Mark

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS

Kit contents Keyboard, installation guide, warranty card, safety and comfort guide

HP PS/2 Scroll Mouse Dimensions 3.8 x 6.3 x 11.6 cm (1.5 x 2.5 x 4.6 in)

> Weight 4.44 oz (126 g)

Environmental Operating temperature 50° to 122° F (10° to 50° C) **Non-operating** 22° to 140° F (-30° to 60° C)

temperature

Operating humidity 10% to 90% (non condensing at ambient) Non-operating humidity 20% to 80% (non condensing at ambient)

Operating shock 40 g, 6 surfaces Non-operating shock 80 g, 6 surfaces **Operating vibration** 2 g peak acceleration Non-operating vibration 4 g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, 6-drop sequence **Drop** (out of box) 1 m on asphalt tile over concrete, 6-drop

sequence

Electrical Operating voltage 5 VDC ± 10%

> **Power consumption** 15 mA

System consumption PS/2 mini-din connector **ESD** CE level 4, 15 kV air discharge

EMI-RFI Conforms to FCC rules for a Class B computing

device

Microsoft **Functionally compliant**

PC99 - 2001



Technical Specifications - Input/Output Devices

Mechanical	Resolution	400 ± 20% DPI

Tracking speed10 in/s (25.4 cm/s) maximumAcceleration100 in/s/s (2.54 m/s/s)Switch actuation65 g nominal peak force

Switch life 1,000,000 operations (using Hasco modified

tester)

Switch type Low force micro-switches

Tracking mechanism life 155 mi (250 km) at average speed of 10 in/s

Cable length 6 ft (1.8 m)

Microsoft PC99 – 2001 Mechanically compliant

Scroll wheel Width 8 mm

Diameter 0.99 in (25.2 mm)

Maximum rotation speed 30 mm/s

Switch typeLight force micro-switchSwitch life1 million operations

Mechanical life Minimum 200,000 revolutions

Regulatory approvals Compliant UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-

3.95 x 6.21 x 11.7 cm (1.56 x 2.44 x 4.61 in)

Tick, MIC

HP PS/2 Optical Scroll Mouse

Dimensions $(H \times L \times W)$

4.44 oz (126 g)

Environmental

Weight

Operating temperature -32° to 104°F (0° to 40° C) **Non-operating** -4° to 140°F (-20° to 60° C)

Non-operating temperature

Operating humidity 10% to 90% (non condensing at ambient)

Non-operating humidity 10% to 90% non condensing

Operating shock40 g, 6 surfacesNon-operating shock80 g, 6 surfacesOperating vibration2 g peak accelerationNon-operating vibration4 g peak acceleration

Drop (out of box) 80 cm height onto asphalt tile over concrete or

equivalent, 5-drop in 5 direction except the cable

face

Electrical Operating voltage 5 VDC ± 10%

Power consumption 100mA

System consumption PS/2 mini-din connector **ESD** CE level 4, 15 kV air discharge

EMI-RFI Conforms to FCC rules for a Class B computing

device

Microsoft PC99 - 2001 Functionally compliant

Technical Specifications - Input/Output Devices

Mechanical Resolution 400 ± 20% DPI Tracking speed 10 in/s (25.4 cm/s) maximum

> **Acceleration** 100 in/s/s (2.54 m/s/s) **Switch actuation** 61 g nominal peak force

Switch life 3,000,000 operations (using Hasco modified

tester)

Switch type Low force micro-switches

Tracking mechanism life 155 mi (250 km) at average speed of 10 in/s

Cable length 6 ft (1.8 m)

Microsoft PC99 - 2001 Mechanically compliant

Scroll wheel Width 8 mm

> 1.01 in (25.6 mm) Diameter

Maximum rotation speed 48 rats/sec

Switch type Light force micro-switch Switch life 1 million operations

Mechanical life Minimum 200,000 revolutions

Regulatory approvals Compliant UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-

Tick, MIC

HP USB Optical Scroll

Mouse

Dimensions (H x L x W)

1.5 x 4.5 x 2.5 in (3.8 x 11.6 x 6.3 cm)

Weight 0.27 lb (0.12 kg) Cable length 72.8 in (185 cm)

System requirements Microsoft Windows 95, 98, 2000, Me, and XP

Available USB port



Technical Specifications - Optical Storage

SATA DVD+/-RW (DL/DF) SuperMulti LightScribe Drive

Height 5.25-inch, half-height, tray-load Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Disc capacity 8.5 GB DL or 4.7 GB standard

Dimensions (W \times H \times D) 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)

Weight (max) 2.6 lb (1.2 kg)

Write speeds **DVD-RAM** Up to 12X

> DVD+R Up to 16X DVD+RW Up to 8X **DVD+RDL** Up to 8X **DVD-R DL** Up to 8X DVD-R Up to 16X **DVD-RW** Up to 6X CD-R Up to 48X CD-RW Up to 32X

Read speeds DVD-RAM Up to 12X

DVD+RW, DVD-RW, DVD+R Up to 8X

DL, DVD-R DL

DVD-ROM DL Up to 8X DVD-ROM, DVD+R, Up to 16X

DVD-R

Random

CD-ROM, CD-R Up to 48X CD-RW Up to 32X

Access time

(typical reads, including

Full Stroke settling) **Power**

Source SATA DC power receptacle

> **DC Power Requirement** 5 VDC ± 5%-100 mV ripple p-p

12 VDC ± 5%-200 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, 1600 mA maximum)

12 VDC (< 600 mA typical, 1400 mA maximum)

DVD: < 140 ms (typical), CD: < 125 ms (typical)

DVD: < 250 ms (seek), CD: < 210 ms (seek)

Environmental conditions Temperature 41° to 122° F (5° to 50° C)

(operating - noncondensing)

Relative Humidity 10% to 90% **Maximum Wet Bulb** 86° F (30° C)

Temperature



Technical Specifications - Optical Storage

SATA DVD+/-RW (DL/DF) **LightScribe Drive**

Height 5.25-inch, half-height, tray-load

Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Disc capacity 8.5 GB DL or 4.7 GB standard

Dimensions $(W \times H \times D)$ 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)

Weight (max) 2.6 lb (1.2 kg)

Write speeds DVD+R Up to 16X

> DVD+RW Up to 8X DVD+R DL Up to 8X **DVD-RDL** Up to 4X DVD-R Up to 16X **DVD-RW** Up to 6X CD-R Up to 48X CD-RW Up to 32X

Read speeds DVD-RAM Up to 4X

DVD+RW, DVD-RW, DVD+R Up to 8X

DL, DVD-R DL

DVD-ROM, DVD+R, Up to 16X

DVD-R

Random

CD-ROM, CD-R Up to 48X

CD-RW Up to 32X

Access time

(typical reads, including

settling) **Power**

Full Stroke DVD: < 240 ms (seek), CD: < 200 ms (seek)

Source SATA DC power receptacle

> **DC Power Requirement** 5 VDC ± 5%-100 mV ripple p-p

> > 12 VDC ± 5%-200 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, 1600 mA maximum)

12 VDC (< 600 mA typical, 1400 mA maximum)

DVD: < 130 ms (typical), CD: < 120 ms (typical)

41° to 122° F (5° to 50° C) **Environmental conditions Temperature**

(operating - non-

condensing)

Relative Humidity

10% to 90%

Maximum Wet Bulb 86° F (30° C)

Temperature

SATA DVD-ROM Drive Height 5.25-inch, half-height, tray-load

> Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Disc capacity Single layer: Up to 4.7 GB (6 times capacity of CD-ROM)

Double layer: Up to 8.5 GB (12 times capacity of CD-ROM)

Dimensions $(W \times H \times D)$ 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)



Technical Specifications - Optical Storage

Weight (max)	2.6 lb (1.2 kg)			
Read speeds	DVD+R/-R/+RW/ -RW/+R DL /-R DL	Up to 8X		
	DVD-ROM	Up to 16X		
	DVD-RAM	Up to 4X		
	CD-ROM, CD-R	Up to 48X		
	CD-RW	Up to 32X		
Removable Storage –	Media	Read	Write	
Media Compatibility –	CD-ROM	Yes	No	
DVD-ROM	CD-R	Yes	No	
	CD-RW	Yes	No	
	DVD-ROM	Yes	No	
	DVD-ROM DL	Yes	No	
	DVD-RAM	Yes	No	
	DVD+R	Yes	No	
	DVD+R DL	Yes	No	
	DVD+RW	Yes	No	
	DVD-R	Yes	No	
	DVD-RW	Yes	No	
	DVD-R DL	Yes	No	
Access times	Random	DVD: < 140 ms (typical), CD: < 125 ms		
(typical reads, including	Full Stroke	DVD: < 250 ms (seek), C	D: < 210 ms (seek)	
setting)	Cache Buffer	2 MB (minimum)		
	Data Transfer Modes		IB/s); ATA Multi-word DMA A UltraDMA Mode 3 (44.4	
Power	Source	SATA DC power recepta	cle	
	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 5%-200 mV ripple p-p		
	DC Current		al, < 1600 mA maximum al, < 1400 mA maximum	
Environmental	Temperature	41° to 122° F (5° to 50°	C)	
(all conditions	Relative Humidity	10% to 90%		
non-condensing)	Maximum Wet Bulb Temperature	86° F (30° C)		



Technical Specifications - Optical Storage

SATA CD-RW/DVD-ROM Combo Drive

Height5.25-inch, half-height, tray-loadOrientationEither horizontal or vertical

Interface type SATA/ATAPI

Disc capacity Single layer: Up to 4.7 GB (6 times capacity of CD-ROM)

Double layer: Up to 8.5 GB (12 times capacity of CD-ROM)

Dimensions (W x H x D) 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)

Weight (max) 2.6 lb (1.2 kg)

Write speeds CD-R Up to 48X

CD-RW Up to 32X

Read speeds DVD+R/-R/+RW/ Up to 8X

-RW/+R DL /-R DL

DVD-ROM Up to 16X CD-ROM, CD-R Up to 48X CD-RW Up to 32X

Access time

(typical reads, including

settling)

Random DVD: < 140 ms (typical), CD: < 125 ms (typical)

Full Stroke DVD: < 250 ms (typical), CD: < 210 ms (typical)

Power Source SATA DC power receptacle

DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p

12 VDC ± 5%-200 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, < 1600 mA maximum)

12 VDC (< 600 mA typical, < 1400 mA maximum)

Environmental (all **Temperature** 41° to 122° F (5° to 50° C)

conditions noncondensing)

Relative Humidity 10% to 90%

Maximum Wet Bulb 86° F (30° C)

Temperature

CD-ROM Drive Interface SATA

Data Transfer Rate Variable (Audio CD) – 1,800 Variable (CD-ROM, CD-R) – 2,400 to 7,200 KB/s

to 3,600 KB/s (24X) Max (48X) Max

Access Time (ms) Random: <125 ms Full-stroke seek: <210 ms

Data Buffer 2MB

Disk Formats Read CD-ROM Mode 1, CD-ROM XA (Mode 2, Form 1 and 2), CD Digital Audio, CD-

EXTRA, CD-I (Mode 2, Form 1 and 2) and CD-I Ready, CD-Text, CD-Bridge, Photo CD (Single and Multi Session), Video CD, CD-R and CD-RW Multi-Session

Disk Formats Written None

Disk Capacity (CD) 180 MB, 54 0MB, 650 MB, and 700 MB

Block Size Mode 1–2,048, 2,352 bytes

Mode 2–1, 2,048, 2,328, 2,336, 2,340, 2,353 bytes Mode 2–2, 2,328, 2,336, 2,340, 2,352 bytes

CD-DA-2,352, 2,368 bytes



Technical Specifications - Optical Storage

Diameter 12 cm; 8 cm **Thickness** 1.2 mm **Track Pitch** 1.6 µm

Audio Output Level Line-out-0.7 V @ 47 Kohm

Startup Time <7 seconds (typical); < 30 seconds with multi-session **Operating Conditions Temperature** 41° to 122° F (5° to 50° C)

> **Relative Humidity** 10% to 90%

Dimensions $(H \times W \times D,$

maximum)

1.7 x 5.9 x 8.0 in (4.3 x 15.0 x 20.3 cm)

Weight 2.6 lb (1200 g)

PATA DVD+/-RW **LightScribe Slim Drive** Height 5.25-inch, half-height, tray-load Orientation Either horizontal or vertical

Interface type ATAPI/EIDE

Disc recording capacity Up to 8.5 GB DL or 4.7 GB standard **Dimensions** $(W \times H \times D)$ 5.0 x 0.5 x 5.0 in (128 x 13.6 x 129 mm)

Weight (max) 0.42 lb (190 g)

Write speeds DVD+R Up to 8X

> **DVD+RW** Up to 8X **DVD+RDL** Up to 4X DVD-R Up to 8X **DVD-RW** Up to 6X CD-R Up to 24X CD-RW Up to 16X

Read speeds DVD+RW, DVD-RW, DVD-Up to 8X

> ROM, DVD+R, DVD-R

DVD-R DL Up to 4X CD-ROM, CD-R Up to 24X CD-RW Up to 24X

Access time

(typical reads, including

settling)

Random DVD: < 140 ms (typical), CD: < 125 ms (typical)

Full Stroke DVD: < 250 ms (seek), CD: < 210 ms (seek)

Stop Time < 4 seconds **Cache Buffer** 2 MB (minimum)

Data Transfer Modes ATA PIO mode 4 (16.7 MB/s); ATA Multi-word DMA

mode 2 (16.7 MB/s); ATA UltraDMA Mode 3 (44.4

MB/s – default)

Power Source Four-pin, DC power receptacle



Technical Specifications - Optical Storage

DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p

12 VDC ± 5%-200 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, 1600 mA maximum)

12 VDC (< 600 mA typical, 1400 mA maximum)

Total Drive Power

(standby mode)

< 2.5 Watt

Audio output Line-Out **0.7 VRMS** 74 dB

Signal-to-Noise Ratio **Channel Separation**

65 dB

Environmental conditions Temperature

(operating - noncondensing)

41° to 122° F (5° to 50° C)

Relative Humidity Maximum Wet Bulb 10% to 90% 86° F (30° C)

Temperature

PATA CD-RW/DVD-ROM **Combo Slim Drive**

Height 12.7mm height slim CD-RW Orientation Either horizontal or vertical

Interface type PATA/ATAPI

Disc capacity Single layer: Up to 4.7 GB (6 times capacity of CD-ROM)

Dimensions $(W \times H \times D)$ 5.0 x 0.5 x 5.0 in (128 x 13.6 x 129 mm)

Weight (max) 0.42 lb (190 g)

Write speeds CD-R Up to 24X

> CD-RW Up to 24X

Read speeds DVD+R/-R/+RW/ Up to 4X

-RW/+R DL /-R DL

DVD-ROM Up to 8X CD-ROM, CD-R Up to 24X CD-RW Up to 24X

Access time

(typical reads, including

settling)

Random DVD DVD: < 140 ms (typical), CD: < 125 ms (typical)

Random CD DVD: < 250 ms (typical), CD: < 210 ms (typical)

Cache Buffer 2 MB (minimum)

Data Transfer Modes ATA PIO mode 4); ATA Multi-word DMA mode 2;

ATA UltraDMA mode 0; ATA UltraDMA mode 1,

mode 2; ATA UltraDMA Mode 3 (default)

Power Four-pin, DC power receptacle Source

> **DC Power Requirement** 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, < 1600 mA maximum)

Total Drive Power < 2.5 Watt

(standby mode)

Audio output level 0.7 Vrms (typical)



Technical Specifications - Optical Storage

Environmental (all

conditions noncondensing) **Temperature** 41° to 122° F (5° to 50° C)

Relative Humidity 5% to 85%

Maximum Wet Bulb 86° F (30° C)

Temperature (operating)

PATA DVD-ROM Slim Drive Height 12.7mm

Orientation Either horizontal or vertical

Interface type PATA/ATAPI

Dimensions (W x H x D) 5.0 x 0.5 x 5.0 in (128 x 13.6 x 129 mm)

Weight (max) 0.42 lb (190 g)

Read speeds DVD+R/-R/+RW/ Up to 4X

-RW/+R DL /-R DL

DVD-ROM Up to 8X
CD-ROM, CD-R Up to 24X
CD-RW Up to 24X

Access time

(typical reads, including

settling)

Random DVD DVD: < 140 ms (typical), CD: < 125 ms (typical)

Random CD DVD: < 250 ms (seek), CD: < 210 ms (seek)

Data Transfer Modes ATA PIO mode 4 (16.7 MB/s); ATA Multi-word DMA

mode 2 (16.7 MB/s)

Power Source Four-pin, DC power receptacle

DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC - <1000 mA typical, < 1600 mA maximum

Total Drive Power < 2.5 Watt

(standby mode)

Audio output Line-Out 0.7 VRMS

Signal-to-Noise Ratio74 dBChannel Separation65 dB

Environmental (all **Temperature** 41° to 122° F (5° to 50° C)

conditions noncondensing)

Relative Humidity 5% to 85%

Maximum Wet Bulb 86° F (30° C)

Temperature (operating)



Technical Specifications - Removable Storage

HP 16-in-1 Media Card Reader **USB Interface** USB 2.0 High-speed device

Advance protocol support Supports hardware ECC (Error Correction Code) function

Supports hardware CRC (Cyclic Redundancy Check) function

• Supports MS 4-bit parallel transfer mode

• Supports MS-PRO 4-bit parallel transfer mode

Supports SD 4-bit parallel transfer mode

Supports high-speed 50-MHz SD 4-bit card (version 1.1)

Support high-speed 52-MHz MultiMediaCard 8-bit card

Supported media type with card adapter

MicroSD (T-Flash)

Memory Stick Micro

Mechanical Environmental

Operational Test Parameters/Conditions – Power applied, unit

Environmental Extremes operating on system ±5% nominal supply voltage.

10°C 10% R.H. = 24 hours 10°C 90% R.H. = 24 hours 20°C 90% R.H. = 24 hours 30°C 90% R.H. = 24 hours 40°C 90% R.H. = 24 hours 50°C 90% R.H. = 24 hours 50°C 10% R.H. = 24 hours

Storage Environmental

Extremes

Test Parameters/Conditions 60°C @ 80% R.H. for 96 hours -30°C @ 20% R.H. for 48 hours

No power applied Delta °C < 1.0°C/min

Delta % R.H. < 1.5% R.H./min

Approvals USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport

Specification Rev. 1.0, Compliant Intel Front Panel I/O Connectivity Design

Guide V. 1.2

FCC, CE, BSMI, C-Tick, VCCI, MIC, cUL, TUV-T



QuickSpecs

Technical Specifications - Environmental Data

Eco-Label Certifications and declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- ENERGY STAR*
- US Federal Energy Management Program (FEMP)
- Taiwan Green Mark
- China Energy Conservation Program
- IT ECO declaration
- EPEAT Rated SILVER
- Korea Eco-label
- EPEAT
- Japan PC Green label**

Ultra-slim Desktop

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Ultra-slim Desktop model is based on a typically configured product.

Energy Consumption

	115 VAC	230 VAC	100 VAC
Normal Operation	105.3 W	103.0 W	106.8 W
Sleep (ENERGY STAR low power mode)	2.74 W	3.00 W	2.76 W
Off	1.58 W	1.85 W	1.57 W
Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	359.3 BTU/hr	351.4 BTU/hr	364.4 BTU/hr
Sleep	9.3 BTU/hr	10.2 BTU/hr	9.4 BTU/hr
Off	5.4 BTU/hr	6.3 BTU/hr	5.4 BTU/hr

^{*} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.



^{*} Select configurations available for ENERGY STAR compliance.

^{**} This product conforms to the examination standards (2003 version) under JEITA's 'PC Green Label System.'

Declared Noise Emissions

(in accordance with ISO 7779 and ISO 9296)

	Souna Power	Souna Pressure
System Fan Off	(LWAd, bels)	(LpAm, decibels)
Idle	3.9	29
Fixed Disk (random writes)	3.9	30
Optical Drive (seguential reads)	4.9	40

Longevity and Upgrading This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- Intel LGA775 processor socket
- 8 USB ports
- 1 empty PCI full-height slot (w/ optional PCI riser card), or 1 empty PCIe low-profile x16 slot (w/optional PCIe riser card)
- 1 internal drive slot
- 1 Slimline optical drive slot
- · 3 memory slots
- 1 Serial/Parallel adapter (optional)

Spare parts are available throughout the warranty period and or for up to 5 years after the end of production.

Batteries

This product complies with ISO standards:

- EU Directive 91/157/EEC
- EU Directive 93/86/EEC
- EU Directive 98/101/EEC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 4000ppm by weight.

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2002/95/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Silver level (see http://www.epeat.net)
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 0% recycled materials (by wt.)
- This product is 92% recyclable when properly disposed of at end of life.



Technical Specifications - Environmental Data

Packaging Materials	Corrugated Paper	1100 g
	EPE Foam	200 g
	I DPF Rag	23 π

- The EPE foam packaging material is made from 30 to 60% recycled content.
- The corrugated paper packaging materials contains at least 80% recycled content.

Small Form Factor

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Small Form Factor Desktop model is based on a typically configured product.

Energy Consumption

	115 VAC	230 VAC	100 VAC
Normal Operation	99.0 W	94.0 W	99.5 W
Sleep (ENERGY STAR low power mode)	2.64 W	2.87 W	2.62 W
Off	1.68 W	1.87 W	1.67 W
Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	337.8 BTU/hr	320.7 BTU/hr	339.5 BTU/hr
Sleep	9.0 BTU/hr	9.8 BTU/hr	8.9 BTU/hr
Off	5.7 BTU/hr	6.4 BTU/hr	5.7 BTU/hr

^{*} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

Declared Noise Emissions

(in accordance with ISO 7779 and ISO 9296)

	Sound Power	Sound Pressure
System Fan Off	(LWAd, bels)	(LpAm, decibels)
Idle	4.0	29
Fixed Disk (random writes)	4.0*	29**
Optical Drive (sequential reads)	5.1	41

^{* 4.6} with 10,000 rpm hard drive



^{** 37} with 10,000 rpm hard drive

Longevity and Upgrading This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- Intel LGA775 processor socket
- 8 USB ports
- 2 empty PCI slots (2 low profile or 2 full-height with optional riser)
- 1 empty PCIe x1 slot
- 1 empty PCIe x16 slot
- 1 internal drive bay
- 1 SATA optical drive bay
- 1 3.5-inch external drive bay
- · 4 memory slots
- 1 second Serial port (optional)

Spare parts are available throughout the warranty period and or for up to 5 years after the end of production.

Batteries

This product complies with ISO standards:

- EU Directive 91/157/EEC
- EU Directive 93/86/EEC
- EU Directive 98/101/EEC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 4000ppm by weight.

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2002/95/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Silver level (see http://www.epeat.net)
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 0% recycled materials (by wt.)
- This product is 91% recyclable when properly disposed of at end of life.

Packaging Materials	Corrugated Paper	1600 g
	EPE Foam	20 g
	LDPE Bag	52 g

- The EPE foam packaging material is made from 30 to 60% recycled content.
- The corrugated paper packaging materials contains at least 80% recycled content.

Convertible Minitower



Technical Specifications - Environmental Data

System Configuration	Processor	Intel Pentium D 945 Processor
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(3.4-GHz, 2x2MB L2 cache, 800-MHz FSB)

Memory 1-GB DDR2 Synch Dram PC2-5300 (667-MHz)

Hard Drive 80-GB SATA 3.0-Gb/s (7200 rpm)

Optical Drive SATA DVD-ROM Drive

Communications Integrated Intel 82566DM Gigabit Network Connection, Agere 2006 PCI 56K

International SoftModem

Energy Consumption

	115 VAC	230 VAC	100 VAC
Normal Operation	92.2 W	87.2 W	91.7 W
Sleep (ENERGY STAR low power mode)	2.38 W	2.88 W	2.34 W
Off	1.01 W	1.45 W	0.98 W
Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	337.8 BTU/hr	320.7 BTU/hr	339.5 BTU/hr
Sleep	9.0 BTU/hr	9.8 BTU/hr	8.9 BTU/hr
Off	5.7 BTU/hr	6.4 BTU/hr	5.7 BTU/hr

^{*} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

Declared Noise Emissions

(in accordance with ISO 7779 and ISO 9296)

	Sound Power	Sound Pressure
System Fan Off	(LWAd, bels)	(LpAm, decibels)
Idle	4.0	23
Fixed Disk (random writes)	4.1*	24**
Optical Drive (sequential reads)	4.9	32



^{* 5.3} with 10,000 rpm hard drive

^{** 37} with 10,000 rpm hard drive

Longevity and Upgrading This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- Intel LGA775 processor socket
- 8 USB ports
- 4 empty full-height PCI slots (2 standard, 2 optional)
- 1 empty full-height PCIe x1 slot
- 1 empty full-height PCIe x16 slot
- 2 internal 3.5-inch drive bays
- 3 external 5.25-inch SATA drive bays
- 1 external 3.5-inch drive bay
- · 4 memory slots
- 1 second Serial port (optional)

Spare parts are available throughout the warranty period and or for up to 5 years after the end of production.

Batteries

This product complies with ISO standards:

- EU Directive 91/157/EEC
- EU Directive 93/86/EEC
- EU Directive 98/101/EEC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 4000ppm by weight.

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2002/95/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Silver level (see http://www.epeat.net)
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 0% recycled materials (by wt.)
- This product is 97% recyclable when properly disposed of at end of life.

Packaging Materials	Corrugated Paper	1642 g
	EPE Foam	399 g
	LDPE Bag	63 g

- The EPE foam packaging material is made from 30 to 60% recycled content.
- The corrugated paper packaging materials contains at least 80% recycled content.

Ultra-slim Desktop, Small Form Factor, Convertible Minitower



RoHS Compliance

Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis. From July 1, 2006, RoHS substances will be virtually eliminated (virtually = to levels below legal limits) for all HP electronic products subject to the RoHS Directive, except where it is widely recognized that there is no technically feasible alternative (as indicated by an exemption under the EU RoHS Directive).

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the

Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted



on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP

equipment.

Hewlett-Packard Corporate Environmental Information

For more information about HP's commitment to the environment:

Corporate Environmental [link to new HP white paper now in progress]

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html

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